

# Silicone Solutions for Electronic Devices and Component Assemblies

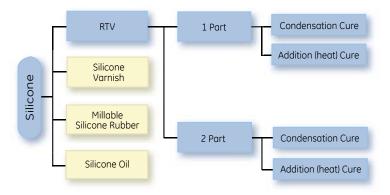


### **Overview**.....1-2 Industry Overview.....3-4 Product Index Adhesives and Sealants .....5-6 Grease......7 Coating Materials.....7-8 Encapsulants / Potting Materials.....9-10 Selection Guide......11-12 **Product Details** 1 Part Condensation Cure......13-19 1 Part Heat Cure.....20-22 2 Part Room Temperature. Cure......23-25 2 Part Heat Cure......26-28 1 Part & 2 Part Gels......29-30 JCR Grades.....31 Grease......32 Packaging Supplement.....32 **UL Chart**......33-34 Technical Information......35-36 **FAQ**......37

### Silicone Product Profile

The products introduced in this selector guide consist of "RTV" (Room Temperature Vulcanizing) silicone products, that are commonly found in Electric and Electronic applications and component assemblies. This family of silicone products consists of both Room Temperature Cure and Heat Cure grades.

GE - Advanced Materials, Silicones, offers a comprehensive portfolio of silicone solutions to help meet a broad array of handling and performance needs in electronic components and assemblies. Selection of the appropriate type of RTV depends upon the required manufacturing process, handling requirements, curing conditions, equipment, and desired material properties.



### Relative Performance Characteristics

Property	Silicone	Ероху	Urethane
Temperature Range	-50 ~ +200°C	-50 ~ +150°C	-30 ~ +120°C
Heat Resistance	Excellent	Poor	Poor
Flame Retardancy <sup>1</sup>	Excellent	None	None
UV Stability	Excellent	Poor	Poor
Ozone Stability	Excellent	Poor	Poor
Modulus	Low	High	High

<sup>&</sup>lt;sup>1</sup> As a base material, silicone demonstrates flame retardant properties comparable to UL94HB

### **Condensation Cure**

Condensation cure silicone products cure when exposed to moisture in the environment at room temperature. These materials are categorized into Alkoxy, Acetoxy, or Oxime based on upon the byproducts that occur during cure.

### **Heat (Addition) Cure**

Heat cure grades cure upon exposure to elevated heat or room temperature.

# APPLICATIONS

#### **SEALING & ADHESION**

Silicones are used in a wide array of applications for bonding components, and sealing against moisture or environmental contaminants. A comprehensive portfolio of 1 Part and 2 Part Adhesives and Sealants, many of which are excellent candidates for assembly applications on or near sensitive electrical and electronic components, are available. These materials are applied by a variety of methods ranging from manual



dispensing to auto-dispensing units for tube, cartridge, pail, or drum packages. Mixing for 2 Part grades may be accomplished by either manual processes or meter mix dispensing, depending on production volume and post-mix material properties.

#### **Performance Considerations**

- Temperature Resistance Dielectric Resistance
- Flame Retardancy
- Adhesion
- Hardness
- Low Volatility
- Mechanical Strength - Thermal Conductivity

### **Process Considerations**

- Viscosity - Cure Temperature
- Pot Life
- Cure Mechanism
- Cure Time

### COATING

The Coating process involves the application of silicone in a thin protective layer to a component surface by methods such as dip, flow, spray, and selective robotic coating. Selection of a silicone coating material for a particular application involves the consideration of various performance and processing criteria.



#### **Performance Considerations**

- Temperature Resistance
- Flame Retardancy
- Low Volatility

- Dielectric Resistance

- Stress Relief

#### **Process Considerations**

- Viscositu
- Cure Mechanism
- Cure Temperature - Pot Life
- Cure Time

POTTING & ENCAPSULATION

Silicone rubber and gels are widely used in electronics to ensure mechanical and environmental protection. A full range of products



are offered in various cure speeds. viscosities, and performance, many of which offer enhancements for thermal cycling protection, stress relief, material strength, flame retardancy, or optical clarity.

#### Performance Considerations

- Temperature Resistance Dielectric Resistance
- Flame Retardancy
- Adhesion
- Release Properties
- Low Volatility
- Stress Relief
- Thermal Conductivity

- Cure Mechanism

#### **Process Considerations**

- Viscosity
- Cure Temperature
- Cure Time
- Pot Life

### Industries Served

### **Electronic Devices and Power Modules**

GE - Advanced Materials is a driving force as a supplier of advanced silicone technology to the electronics industry. Increasing electronic component densities and performance demands have created a need for specialized silicone solutions from GE for a broad mix of performance and handling requirements.

### **Typical Applications:**

- Power converters
- Inverters
- Hybrid ICs
- Micro-Electronic packaging
- High-voltage component insulation
- Membrane switches
- Photo couplers



Silicones are found in board-level adhesion, coating, and encapsulation applications, and contribute to the long-term, reliable performance of many components and assemblies. A wide portfolio of products is available, providing flame retardancy, thermal conductivity, temperature resistance, low-volatility, or high-purity benefits.

### **Typical Applications:**

- Board-level component adhesion, fixing, and sealing
- PCB coating
- Component encapsulation
- Junction Coating Resins



### **Consumer Electronics**

Silicones are commonly used in a variety of consumer electronics applications. In addition to providing adhesion to many substrates, an array of grades are available to provide heat resistance, flame retardancy, low volatility for sensitive components, and moisture protection.

### Typical Applications:

- Flat panel display electrode sealing
- CRT wedges, bases, anodes
- Steam iron plate seals
- Air conditioner units
- Control panel insulation
- PCB fixing and sealing



### **Automotive Electronics**

The automotive industry plays a critical role in integrating new electronic technologies. As more and more components migrate to electronic solutions, silicones play an increasingly important role in helping deliver material solutions that contribute to design flexibility and long-term component reliability under harsh operating conditions.

### Typical Applications:

- ECU potting, sealing, coating
- Wire connector sealing
- Sealing, encapsulation in a broad range of sensors
- HVAC system sealing
- Vibration dampening
- Headlamp assemblies



Avionics and frame assembly needs in Aviation and Aerospace are served through silicone adhesives, coating, encapsulation and potting materials that help withstand stress and temperature extremes.

#### Tupical Applications:

- Avionics
- Circuit and terminal protection
- Wire sealants
- Engine gasketing
- Cargo door, window sealing
- Weatherstrip adhesives
- Aviation lighting
- Ventilation ducts

### **Solar Energy**

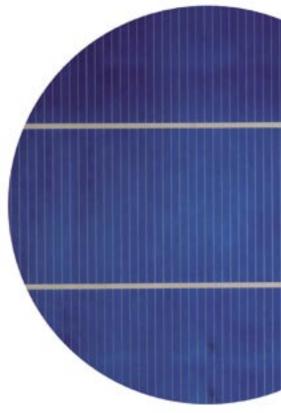
Reliability of electronic components and the ability for panels to withstand harsh conditions over the lifecycle of the product are important considerations in solar energy applications. GE - Advanced Materials, Silicones helps serve this growing industry with its range of potting materials and sealants.

### Typical Applications:

- Terminal box potting
- Box and base sealing
- Aluminum frame and glass / EVA plate sealing







Produc	ct Overview:			
Tupo	Grade	Cure	Cured	Footure
Type	Grade	Chemistry	Property	Feature
	RTV133	Alkoxy	Rubber	UL recognized non-flowable sealant.
	RTV167	Alkoxy	Rubber	High-strength paste adhesive with UL recognition and Mil Spec.
	RTV1673LV	Alkoxy	Rubber	Low volatile, paste adhesive. Non-corrosive to aluminum and steel.
	TSE385 TSE3853-W	Alkoxy Alkoxy	Rubber Rubber	Paste adhesive with Mil Spec. Suitable for PC substrates.  UL recognized, semi-flowable paste. Mil Spec.
	TSE3854D	Alkoxy	Rubber	UL recognized paste adhesive. Mil Spec.
	TSE392	Alkoxy	Rubber	Fast tack, UL recognized paste adhesive.
	TSE3925	Alkoxy	Rubber	Low volatile variant of TSE392.
	TSE3940	Alkoxy	Rubber	Fast tack,UL recognized paste adhesive.
	TSE3941	Alkoxy	Rubber	Fast tack, thermally conductive paste adhesive. UL recognized.
	TSE3941M	Alkoxy	Rubber	Fast tack, thermally conductive flowable sealant. Mil Spec.
	TSE3944 TSE3945	Alkoxy Alkoxy	Rubber Rubber	Low volatile, UL recognized flowable sealant. Mil Spec.  Fast tack, low volatile, UL recognized paste adhesive.
	TSE3946	Alkoxy	Rubber	Fast tack, low volatile, of recognized paste dariesive.  Fast tack, low volatile, thermally conductive paste. UL recognized.
⊢	TSE397	Alkoxy	Rubber	Flowable adhesive / sealant. Mil Spec.
Part	TSE3971	Alkoxy	Rubber	Flowable adhesive / sealant. Mil Spec.
7	TSE3972	Alkoxy	Rubber	Fast tack variant of TSE397.
Condensation	TSE3975	Alkoxy	Rubber	Fast tack, low volatile adhesive / sealant. Mil Spec.
nc	TSE3976-B	Alkoxy	Rubber	Low volatile, temperature resistant sealant. UL recognized.
er	XE11-B5320	Alkoxy	Rubber	Fast tack, low volatile, thermally conductive paste adhesive.
ารเ	XE16-508	Alkoxy	Rubber	Electro-conductive paste adhesive.
<u> </u>	FRV1106 IS5628E	Acetoxy	Rubber Rubber	Fuel, solvent, chemical, and temperature-resistant fluoro sealant.
S S	IS800 series	Acetoxy Acetoxy	Rubber	High strength sealant.  UL recognized paste adhesive. FDA, USDA, and NSF compliant.
Cure	IS806	Acetoxy	Rubber	UL recognized paste danesive. 12A, 03DA, and NSF compilant.  UL recognized, temperature-resistant adhesive. FDA, USDA, and NSF compliant.
	RTV100 series	Acetoxy	Rubber	FDA, USDA, and NSF compliant paste adhesive. Mil Spec.
	RTV106	Acetoxy	Rubber	Temperature-resistant adhesive. FDA, USDA, and NSF compliant. Mil Spec.
	RTV116	Acetoxy	Rubber	Temperature-resistant flowable sealant. FDA, USDA, and NSF compliant. Mil Spec.
	RTV157	Acetoxy	Rubber	High strength paste / adhesive.
	RTV159	Acetoxy	Rubber	High strength paste / adhesive. Temperature-resistant.
	TSE370	Acetoxy	Rubber	Fast tack, general purpose paste adhesive.
	TSE382	Oxime	Rubber	Fast tack, general purpose adhesive paste. UL recognized.
	TSE3826 TSE3840-G	Oxime Oxime	Rubber Rubber	Fast tack adhesive for high-temperature applications.  UL recognized general purpose adhesive / sealant.
	TSE3843-W	Oxime	Rubber	UL recognized general purpose adhesive / sealant.
	TSE384-B	Oxime	Rubber	UL recognized general purpose adhesive / sealant.
	TSE387	Oxime	Rubber	General purpose flowable adhesive / sealant.
	TSE3877-B	Oxime	Rubber	Flowable sealant for high-temperature applications.
	TSE3878	Oxime	Rubber	Paste type adhesive / sealant for high-temperature applications.
	TSE388	Oxime	Rubber	Flowable general purpose adhesive / sealant.
	Addisil 8101	Heat	Rubber	Paste adhesive with fast cure capability at elevated temperatures. Good storage stability.
	TSE3212	Heat	Rubber	Thixotropic adhesive / sealant.
<b>—</b>	TSE322 TSE3221S	Heat Heat	Rubber Rubber	Flowable adhesive / sealant. Flowable adhesive / sealant.
Pa	TSE322S	Heat	Rubber	UL recognized, semi-flowable adhesive / sealant.
7	TSE326	Heat	Rubber	UL recognized, high temperature-resistant adhesive / sealant.
Part Heat Cure	TSE3260	Heat	Rubber	UL recognized, high temperature-resistant adhesive / sealant.
Qt .	TSE3261-G	Heat	Rubber	High temperature-resistant adhesive / sealant.
C	TSE326M <sup>1</sup>	Heat	Rubber	High temperature-resistant adhesive / sealant.
<u> </u>	TSE3280-G	Heat	Rubber	Thermally conductive adhesive.
	TSE3281-G	Heat	Rubber	Thermally conductive adhesive.
	TSE3282-G	Heat	Rubber	High thermally conductive adhesive.  General purpose adhesive / sealant.
	XE13-B3208 RTV223	Heat Condensation	Rubber Rubber	High strength adhesive with fast tack and cure performance.
2 Part Room Temp.	RTV566	Condensation	Rubber	Low volatile, high-low temperature-resistant adhesive.
mg	RTV577	Condensation	Rubber	Extreme low temperature resistant sealant. Release capability.
.> ⊃ .∔	RTV88	Condensation	Rubber	Semi-flowable temperature-resistant sealant. Release capability.
2	LVG342	Heat	Rubber	Low volatile adhesive. Fast cure at elevated temperatures.
Pa	RTV658	Heat	Rubber	Low volatile adhesive. Fast cure at elevated temperatures.
Part Heat Cure	TSE3320	Heat	Rubber	General purpose, semi-flowable adhesive / sealant.
e H	TSE3360	Heat	Rubber	General purpose adhesive / sealant.
gt	TSE3380	Heat	Rubber	Thermally conductive adhesive. Fast cure at elevated temperatures.
• • •	XE14-A0425	Heat	Rubber	Heat resistant, thermally conductive adhesive.

			P	erformanc	e				
=1 1.11.	Flame	Low		High Temp.		Electro-	FDA		Product
Flowability	Retardancy	Volatility	Conductive	Resistance	Resistance	Conductive		Mil-Spec	Detail
Non-flowable	UL94 V-0								P. 13
Non-flowable	UL94 HB							MIL-A-46146	P. 13
Non-flowable									P. 13
Non-flowable								MIL-A-46146B	P. 13
Semi-flowable	UL94 V-0							MIL-A-46146B	P. 14
Non-flowable	UL94 V-0							MIL-A-46146B	P. 13
Non-flowable	UL94 HB							MIL-A-46146B	P. 13
Non-flowable	111.06.14.0							MIL-A-46146B	P. 13
Non-flowable Non-flowable	UL94 V-0 UL94 V-1							MIL-A-46146B MIL-A-46146B	P. 14 P. 14
Flowable	0L94 V-1							MIL-A-46146B	P. 14 P. 15
Semi-flowable	UL94 V-0							MIL-A-46146B	P. 15
Non-flowable	UL94 V-0	•						MIL-A-46146B	P. 14
Non-flowable	UL94 V-1	•	•					MIL-A-46146B	P. 14
Flowable	UL94 HB							MIL-A-46146B	P. 15
Flowable								MIL-A-46146B	P. 14
Flowable								MIL-A-46146B	P. 15
Flowable								MIL-A-46146B	P. 15
Flowable	UL94 HB							MIL-A-46146B	P. 14
Non-flowable			•						P. 14
Non-flowable Non-flowable									P. 14 P. 18
Flowable									P. 10 P. 19
Non-flowable	UL94 HB								P. 18
Non-flowable	UL94 HB			•					P. 18
Non-flowable								MIL-A-46146	P. 18
Non-flowable							•	MIL-A-46146	P. 18
Flowable								MIL-A-46146	P. 19
Non-flowable				_					P. 18
Non-flowable									P. 18
Non-flowable									P. 18
Non-flowable	UL94 HB								P. 16
Non-flowable Semi-flowable	UL94 V-0								P. 16 P. 17
Semi-flowable									P. 17
Non-flowable									P. 17
Flowable									P. 17
Flowable									P. 17
Non-flowable									P. 17
Flowable									P. 17
Non-Flowable									P. 20
Semi-flowable									P. 20
Flowable									P. 20
Flowable Semi-flowable	UL94 HB								P. 21 P. 20
Flowable	UL94 HB								P. 20 P. 21
Flowable	UL94 HB								P. 21
Flowable	2_0.710								P. 20
Flowable									P. 21
Flowable									P. 21
Flowable			•						P. 21
Flowable									P. 21
Non-flowable									P. 20
Non-flowable Flowable									P. 23
Non-flowable									P. 23 P. 23
Semi-flowable									P. 23
Non-Flowable		•							P. 26
Non-flowable		•							P. 26
Semi-flowable			•						P. 26
Non-flowable									P. 26
Flowable				_					P. 27
Semi-flowable	tions may apply to co	atalia aan						c regions	P. 26

Product Overview: Coating Materials

Produ	<u>ict Overview:</u>				
_		Cure	Cured		
Type	Grade	Chemistry	Property	Feature	
	ECS0600	Alkoxy	Rubber	High purity repairable electrode coating. Fast tack.	
	ECS0601	Alkoxy	Rubber	High purity, non-repairable type electrode coating. UL recognized.	
	RTV160	Alkoxy	Rubber	UL recognized flowable sealant.	
	TSE3941M	Alkoxy	Rubber	Fast tack, thermally conductive flowable sealant. Mil Spec.	
	TSE3944	Alkoxy	Rubber	Low volatile, UL recognized flowable sealant. Mil Spec.	
	TSE397	Alkoxy	Rubber	Flowable sealant. Mil Spec.	
Part Condensation	TSE3971	Alkoxy	Rubber	Flowable sealant. Mil Spec.	
1	TSE3972	Alkoxy	Rubber	Fast tack variant of TSE397.	
0	TSE3975	Alkoxy	Rubber	Fast tack, low volatile sealant. Mil Spec.	
nd	TSE3976-B	Alkoxy	Rubber	Low volatile, temperature resistant sealant. UL recognized.	
<u> </u>	TSE398	Alkoxy	Rubber	Pourable coating / encapsulant. Mil Spec.	
150	TSE399	Alkoxy	Rubber	Low viscosity coating / potting material. Mil Spec.	
의 :	TSE3991	Alkoxy	Rubber	Low viscosity variant of TSE399.	
9	TSE3995	Alkoxy	Rubber	Low volatile variant of TSE399.	
10	TSE3996	Alkoxy	Rubber	Low volatile variant of TSE3991.	
Cure	XE11-A5133S	Alkoxy	Rubber	Low volatile, UL recognized, thermally conductive coating & potting.	
<b>o</b>	RTV110 series	Acetoxy	Rubber	General purpose coating / encapsulant. FDA, USDA, and NSF compliant. Mil Spec.	
	TSE387	Oxime	Rubber	General purpose flowable sealant / coating.	
	TSE3877-B	Oxime	Rubber	Flowable sealant for high-temperature applications.	
	TSE388	Oxime	Rubber	Flowable, general purpose sealant / coating.	
	TSE389	Oxime	Rubber	Flowable, UL recognized coating / sealant.	
	ECC4865	Heat	Rubber	Extreme low viscosity coating material with UV tracer.	
	TSE3221S	Heat	Rubber	Flowable sealant / coating material.	
	TSE325	Heat	Rubber	Flowable coating / encapsulant.	
<b>—</b>	TSE3250	Heat	Rubber	Flowable coating / encapsulant.	
Part	TSE3251	Heat	Rubber	Flowable coating material.	
l ä	TSE3251-C	Heat	Rubber	Flowable coating material.	
<del> </del>	TSE3252	Heat	Rubber	Flowable coating material.	
l e	TSE3253	Heat	Rubber	UL recognized coating / encapsulation.	
Heat Cure	TSE325-B	Heat	Rubber	Flowable coating / encapsulant.	
<u> </u>	TSJ3155	Heat	Rubber	High purity JCR-grade white rubber.	
<b>I</b>	TSJ3190	Heat	Rubber	High purity JCR-grade transparent rubber	
	TSJ3190	Heat	Rubber	High purity JCR-grade black rubber.	
	TSJ3194		Gel	High purity JCR-grade white gel.	
	TSJ3193-W	Heat Heat	Gel	High purity JCR-grade translucent gel.	
	RTV11	Condensation	Rubber	General purpose encapsulation and potting. FDA compliant.	
	RTV511	Condensation	Rubber	Extreme low temperature-resistant coating. Excellent release properties.	
2 Part Temp.	RTV560		Rubber	High-low temperature resistant coating. Excellent release properties.	
39	RTV567	Condensation Condensation	Rubber	Low volatile, extreme low temperature-resistant coating. Release capability.	
P. ←	RTV60	Condensation	Rubber	Extreme high temperature-resistant coating / potting. Release capability.	
Room Cure		Condensation	Rubber	General purpose coating / potting material. Mil Spec.	
l e m	RTV8111	Condensation	Rubber		
	RTV8112	Condensation		General purpose coating / potting material. Mil Spec.	
2	RTV8262		Rubber	High temperature-resistant coating / potting. Release capability and Mil Spec.	
	TSE3033	Heat	Rubber	Transparent coating / encapsulant. Fast cure at elevated temperatures.	
Part Heat Cure	TSE3330	Heat	Rubber	Thermally conductive coating / encapsulant.	
<u> </u>	TSE3331	Heat	Rubber	UL recognized, thermally conductive, coating / encapsulant.	
<del>l</del> e	TSE3331K <sup>1</sup>	Heat	Rubber	Low viscosity variant of TSE3331.	
Qt Qt	TSE3331K EX <sup>1</sup>	Heat	Rubber	Low viscosity variant of TSE3331.	
0	XE14-B3445	Heat	Rubber	High purity JCR-grade translucent rubber.	
<u> </u>	XE14-B5778	Heat	Rubber	High purity JCR-grade translucent rubber.	
O	TSJ3175	Heat	Gel	High purity JCR-grade thixotropic gel.	

Grease - Pro	rease - Product Index			Performance				
Grade	Feature	Thermally Conductive	Low Bleed	Low Volatility	Heat Resistant	Product Detail		
TSK5303	Moderate thermal conductivity with heat resistance.	•		•	•	P. 32		
TSK5370	General electrical insulation. Swell resistant on silicone.			•		P. 32		
TSK550	General electrical insulation, arc resistance.					P. 32		
TSK551	Insulator protection from salt, dust.					P. 32		
YG6111	Moderate thermal conductivity.					P. 32		
YG6240	Moderate thermal conductivity, low-bleed performance.					P. 32		
YG6260	Moderate thermal conductivity.					P. 32		
TIG1000	High thermal conductivity.					P. 32		

**Product** 

Detail

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P. 17

Mil-Spec

MIL-A-46146B

MIL-A-46146

JCR-Grade

Purity

FDA

Product maex: Coating Materials

Flowable Flowable Flowable Flowable Flowable Semi-flowable Semi-flowable Semi-flowable Semi-flowable Semi-flowable Flowable	ble								P. 18 P. 22 P. 21 P. 22
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Semi-flowable Flowable	ble ble						•		P. 31
Semi-flowable Flowable	ble						•		P. 31
Flowable									P. 31
Flowable							•		P. 31
Flowable									P. 24
Flowable					•				P. 24
Flowable Flowable Flowable Flowable Flowable Flowable Flowable Flowable Flowable Semi-flowable				•	•				P. 24
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Flowable Flowable Flowable Flowable Flowable Flowable Flowable Semi-flowable									P. 23
Flowable Flowable Flowable Flowable Flowable Flowable Semi-flowable								MIL-S-23586E	P. 24
Flowable Flowable Flowable Flowable Flowable Semi-flowable								MIL-S-23586E	P. 24
Flowable Flowable Flowable Flowable Semi-flowable								MIL-S-23586E	P. 23
Flowable Flowable Flowable Semi-flowab									P. 28
Flowable Flowable Semi-flowab			•						P. 27
Flowable Semi-flowab			•						P. 28
Semi-flowab	0 - 5		•						P. 28
		0	•						P. 28
C : 0 I-									P. 31
Semi-flowab									P. 31
Semi-flowab	ble								P. 31
Regulatory re	ble ble	to certain pr□				<sup>1</sup> TSE3331K for <i>i</i>	Asia Pacific, TSE3	<b>c regions</b> 331K EX for Europe and t	s or countries the Americas

Performance

Thermally High Temp. Low Temp.

Conductive Resistance Resistance Compliant

Low

Volatility

•

Flame

Retardancy

UL94 HB

UL94 HB

UL94 HB

UL94 V-1

Flowability

Flowable

Flowable

Flowable

Flowable

Flowable Flowable

Flowable

Flowable

Flowable

Flowable Flowable

Flowable

Flowable Flowable

Flowable

Flowable

Flowable

Flowable Flowable

Semi-flowable UL94 V-0

Product Overview: Encapsulants and Potting Materials

roda	ct Overview:	Cure	Cured	
Type	Grade	Chemistry	Property	Feature
0	RTV160	Alkoxy	Rubber	UL recognized flowable encapsulant.
1 Part Condensation	TSE398	Alkoxy	Rubber	Pourable coating / encapsulant. Mil Spec.
de	TSE399	Alkoxy	Rubber	Low viscosity potting / coating material. Mil Spec.
ng ng	TSE3991	Alkoxy	Rubber	Low viscosity variant of TSE399.
ä P	TSE3995	Alkoxy	Rubber	Low volatile variant of TSE399.
<u> </u>	TSE3996	Alkoxy	Rubber	Low volatile variant of TSE3991.
3	XE11-A5133S	Alkoxy	Rubber	Low volatile, UL recognized, thermally conductive coating & potting.
Cure	RTV110 series	Acetoxy	Rubber	General purpose coating / encapsulant. FDA, USDA, and NSF compliant. Mil Spec.
	RTV116	Acetoxy	Rubber	Temperature-resistant flowable sealant. FDA, USDA, and NSF compliant. Mil Spec.
Н	TSE325	Heat	Rubber	Flowable coating / encapsulant.
	TSE3250	Heat	Rubber	Flowable coating / encapsulant.
Ω̈́	TSE3253	Heat	Rubber	UL recognized coating / encapsulation.
<del>-</del>	TSE325-B	Heat	Rubber	Flowable coating / encapsulant.
Part Heat	TSE3051	Heat	Gel	Low viscosity potting gel.
αt	TSE3051-FR	Heat	Gel	UL recognized variant of TSE3051.
0	TSE3051-L	Heat	Gel	Low penetration variant of TSE3051.
Cure	TSE3051ST	Heat	Gel	High strength variant of TSE3051.
Œ	TSE3053	Heat	Gel	High penetration gel.
	RTV11	Condensation	Rubber	General purpose encapsulation and potting. FDA compliant.
	RTV12	Condensation	Rubber	Low viscosity, vibration-dampening soft rubber potting material w/ visual clarity.
2	RTV31	Condensation	Rubber	High temperature resistant potting, Excellent release properties.
	RTV41	Condensation	Rubber	General purpose sealant with excellent release properties. FDA compliant.
Part Room Temp. Cure	RTV511	Condensation	Rubber	Extreme low temperature-resistant potting. Excellent release properties.
<del>7</del>	RTV560	Condensation	Rubber	High-low temperature resistant potting. Excellent release properties.
00	RTV566	Condensation	Rubber	Low volatile, high-low temperature-resistance.
3	RTV567	Condensation	Rubber	Low volatile, extreme low temperature-resistant potting. Release capability.
Te	RTV60	Condensation	Rubber	Extreme high temperature-resistant coating / potting. Release capability.
3	RTV8111	Condensation	Rubber	General purpose potting / coating material. Mil Spec.
o.	RTV8112	Condensation	Rubber	General purpose potting / coating material. Mil Spec.
	RTV8262	Condensation	Rubber	High temperature-resistant coating / potting. Release capability and Mil Spec.
re e	TSE350	Condensation	Rubber	Flowable potting / encapsulant with excellent release properties.
	TSE352	Condensation	Rubber	Flowable potting / encapsulant with excellent release properties.
	TSE3663	Condensation	Rubber	Flowable encapsulant / potting material.
	TSE3664	Condensation	Rubber	UL recognized, flowable encapsulant / potting material.
	RTV615	Heat	Rubber	High strength potting material. Fast cure at elevated temperatures.
	RTV6428	Heat	Rubber	UL recognized low-viscosity encapsulant. Fast cure at low temperatures.
	TSE3032	Heat	Rubber	Transparent potting / encapsulant with excellent release properties.
	TSE3033	Heat	Rubber	Low viscosity, transparent potting material. Fast cure at elevated temperatures.
	TSE3330	Heat	Rubber	Thermally conductive encapsulant / coating.
	TSE3331	Heat	Rubber	UL recognized, thermally conductive, coating / encapsulant.
	TSE3331K <sup>1</sup>	Heat	Rubber	Low viscosity variant of TSE3331.
2	TSE3331K EX <sup>1</sup>	Heat	Rubber	Low viscosity variant of TSE3331.
Pc	TSE3337	Heat	Rubber	High-strength potting / encapsulant.
Ę.	TSE3423	Heat	Rubber	UL recognized, thermally conductive encapsulant. Low temperature cure.
I	TSE3431	Heat	Rubber	UL recognized, thermally conductive potting maerial. Release capability.
e Q	TSE3431-H	Heat	Rubber	UL recognized, thermally conductive potting maerial. Release capability.
<b>+</b>	XE14-B7892	Heat	Rubber	UL recognized low-viscosity potting material. Low temperture cure. Release capability.
Part Heat Cure	YE5822	Heat	Rubber	Low viscosity potting material. Excellent release properties.
ര	RTV6126-D1	Heat	Gel	Low viscosity potting gel with extreme fast cure at low temperatures.
	RTV6136-D1	Heat	Gel	Low viscosity potting gel with fast cure at low temperatures.
	RTV6156	Heat	Gel	Extended low temperature performance potting gel.
	RTV6186	Heat	Gel	High strength potting gel with extended pot life characteristics.
	TSE3062	Heat	Gel	Fast cure at low temperatures.
	TSE3065	Heat	Gel	Low volatile potting gel.
	TSE3070	Heat	Gel	High-elongation gel with low temperature cure.
	TSE3080	Heat	Gel	Thermally conductive potting gel.
	TSE3081			Thermally conductive potting gel.

 $<sup>^{\</sup>rm 1}\,{\rm TSE3331K}$  for Asia Pacific, TSE3331K EX for Europe and the Americas

Flowebility   Flowebile   Fl				Perfori	mance				Decelor
Flowable   U.194 HB   MILA-461466 P. 16   MILA-461468 P. 15   MILA-46146 P. 15   MILA	Flowability							Mil-Spec	Product Detail
Flowable	Ŭ		volatility	Conductive	Resistance	Resistance	Compliant	'	
Flowable		UL94 HB						MU A (61/6D	P. 15
Flowable									
Flowable									P. 16
Flowable									
Flowable   Ll.94 V-1			-						
Flowable									
Flowbile		UL94 V-1	•	•					
Flowable							•		
Flowable   P. 22					•		•	MIL-A-46146	P. 19
Semi-Rowable   P. 22									P. 22
Flowable									P. 22
Flowable		UL94 V-1							P. 22
Flowable									
Flowable									
Flowable		UL94 V-1							
Flowable									P. 29
Flowable									P. 29
Flowable									P. 29
Flowable							•		P. 24
Flowable					_				P. 25
Flowable					•				P. 24
Flowable									P. 23
Flowable						•			
Flowable					•	•			P. 24
Flowable			•		•	•			
Flowable			•			•			P. 24
Flowable					•				P. 23
Flowable   Flowable									
Flowable									
Flowable					•			MIL-S-23586E	
Flowable   UL94 V-0   P. 25     Flowable   UL94 V-0   P. 25     Flowable   Flowable   P. 27     Flowable   P. 28     Flowable   P. 28     Flowable   P. 27     Flowable   P. 28     Flowable   P. 27     Flowable   P. 28     Flowable   P. 28     Flowable   P. 28     Flowable   UL94 V-0   P. 28     Flowable   UL94 V-0   P. 28     Flowable   P. 27     Flowable   UL94 V-0   P. 27     Flowable   UL94 V-0   P. 27     Flowable   UL94 V-0   P. 27     Flowable   P. 28     Flowable   P. 29     Flowable   P. 20     Flowable   P. 20     Flowable   P. 20     Flo									P. 24
Flowable   UL94 V-0   P. 25     Flowable   Flowable   P. 27     Flowable   UL94 V-1   P. 28     Flowable   P. 27     Flowable   P. 28     Flowable   P. 28     Flowable   P. 28     Flowable   P. 28     Flowable   UL94 V-0   P. 26     Flowable   UL94 V-0   P. 27     Flowable   UL94 V-0   P. 27     Flowable   UL94 V-0   P. 27     Flowable   UL94 V-0   P. 28     Flowable   Flowable   P. 29     Flowable   P. 29     Flowable   P. 29     Flowable   P. 30     Flowable   P. 30     Flowable   P. 29     F									
Flowable   P. 27									P. 25
Flowable		UL94 V-0							P. 25
Flowable							•		
Flowable		UL94 V-1							P. 28
Flowable   P. 27									
Flowable   UL94 V-0   P. 28									
Flowable				•					
Flowable   UL94 V-0   P. 28									
Flowable   P. 26				•					
Flowable   UL94 V-1		UL94 V-0							
Flowable   UL94 V-0   P. 27									
Flowable   UL94 V-0   P. 27									
Flowable         UL94 V-0         P. 28           Flowable         P. 29           Flowable         P. 29           Flowable         P. 30           Flowable         P. 30           Flowable         P. 30           Flowable         P. 29				•					
Flowable         P. 28           Flowable         P. 29           Flowable         P. 30           Flowable         P. 30           Flowable         P. 30           Flowable         P. 29									
Flowable         P. 29           Flowable         P. 30           Flowable         P. 30           Flowable         P. 30           Flowable         P. 29		UL94 V-0							
Flowable         P. 29           Flowable         P. 30           Flowable         P. 30           Flowable         P. 29									
Flowable									
Flowable P. 30 Flowable P. 29									
Flowable P. 29						•			
Flowable P. 29 Flowable P. 29 Flowable P. 29									
Flowable P. 29 Flowable P. 29									
Flowable P. 29									
Flowable P. 29									
	Flowable								P. 29

Regulatory restrictions may apply to certain  $\text{pr} \square$ 

c regions or countries.

Selection	Guide						
1 Part Grade		-Rubber RED=Ge	ls Al	koxy	Acetoxy	Oxime	Heat
Viscosity		I	F	Performance			
Range	Thermally Conductive TSE3941	Low Volatility RTV1673LV	UL Recognized TSE3854D	Temp. Resistant	Electro- Conductive XE16-508	FDA Compliant	General Purpose TSE385
Non-	TSE3946 XE11-B5320	TSE3925 TSE3944 TSE3945 TSE3946 XE11-B5320	TSE392 TSE3940 TSE3941 TSE3944 TSE3945 TSE3946 RTV133				
Flowable			IS800 IS806	FRV1106 IS806 RTV106		IS800 IS806 RTV100 RTV106	RTV157 TSE370
				Addisil 8101			XE13-B3208
			TSE382 TSE3840-G TSE384-B TSE389	TSE3826 TSE3878			
High Viscosity		TSE3976-B	TSE3853-W TSE3976-B	TSE3976-B			TSE3971
	TSE3843-W		TSE3843-W	TSE3877-B			וכבכספד
Viscosity				RTV159			TSE3212 TSE322
	TSE3941M XE11-A5133S	TSE3975 XE11-A5133S	XE11-A5133S RTV160 RTV167				TSE397 TSE3972 TSE398
Medium Viscosity			RTV110	RTV116		RTV110 RTV116	TSE387 TSE388
	TSE3280-G TSE3281-G TSE3282-G		TSE322S TSE3253 TSE3260	TSE326 TSE3260 TSE3261-G TSE326M			TSE3221S TSE3251H TSE3251H-C
		ECS0600 ECS0601 TSE3995 TSE3996					TSE399 TSE3991
Low Viscosity			TSE3051FR				ECC4865 TSE3051 TSE3051-L TSE3051ST TSE3053 TSE3255 TSE3250 TSE3251 TSE3251-C TSE3252-C

Cure System Performance Guide

Attribute	Alk	оху	A cotovii	Oxime	Heat Cure	
710110000	Fast Cure	Slow Cure	Acetoxy	Oxime		
Cure Byproduct	Alcohol	Alcohol	Acetic Acid	Methylethyl Ketoxime	None	
Cure Speed	Fast	Slow	Fast	Moderate	Very Fast	
Corrosion on Copper	None	None	Yes	Yes	None	
Corrosion on Metals	None	None	Yes	None	None	
Odor	Low	Low	Strong	Low	None	
Strength	Good	Good	Very Strong	Good	Good	

2 Part Grades		BLACK=Rub	ber RED=Gels	Room 7	Heat			
Missositu		Performance						
Viscosity Range	Thermally Conductive	Low Volatility	UL Recognized	Temp. Resistant	FDA Compliant	General Purpose		
Non- Flowable		LVG342 RTV658				TSE3360 RTV223		
High Viscosity				XE14-A0425 RTV577 RTV88		RIVZZ3		
	TSE3081 TSE3380			111100		TSE3320 TSE3337		
Medium Viscosity		RTV566		RTV31 RTV511 RTV560 RTV566 RTV60 RTV8262	RTV11 RTV41	RTV8112 TSE350		
Low Viscosity	TSE3080 TSE3331 TSE3331K TSE3423	TSE3065	RTV6428 TSE3331 TSE33331K TSE3423 TSE3431 TSE3431-H XE14-B7892	RTV6156	RTV615	RTV6126-D1 RTV6136-D1 RTV6186 TSE3032 TSE3033 TSE3062 TSE3070 TSE3330 YE5822		
		RTV567	RTV567 TSE3664			RTV12 RTV8111		



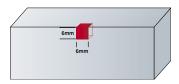
Viscosity and flowability of the silicone material are often key factors in the selection of a material for use in sealing, coating, and encapsulation / potting applications. A broad array of material performance and viscosity combinations are provided to help match the requirements of many applications.

TSE352 TSE3663

### Application Geometry and Cure Chemistry Options

The shape and conditions of the part are important in selecting the suitable silicone grade for each application. The following are some general guidelines:

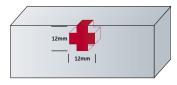
### **Shallow Cavity / Small Mass**



#### Selection Options:

- 1 Part Condensation Cure
- 1 Part Heat Cure
- 2 Part Room Temp. Cure
- 2 Part Heat Cure

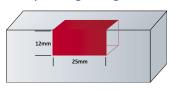
### Complex Design - Exposed Surface



### Selection Options:

- 1 Part Heat Cure
- 2 Part Room Temp. Cure
- 2 Part Heat Cure

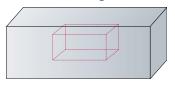
### Deep Cavity / Large Mass



### Selection Options:

- 1 Part Heat Cure
- 2 Part Room Temp. Cure
- 2 Part Heat Cure

### **Enclosed System**



### Selection Options:

- 1 Part Heat Cure
- 2 Part Heat Cure

Properties		RTV1673LV	RTV167	RTV133	TSE385	TSE3854D	TSE392	TSE3925	
Cure Chemistry		Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy	
Flowability		Non-Flowable	Non-Flowable	Non-Flowable	Non-Flowable	Non-Flowable	Non-Flowable	Non-Flowable	
Features and Benefit	S	Low volatile, paste adhesive. Non-corrosive to aluminum and steel.	High strength, paste adhesive with MIL- A-46146B and UL recognition	UL recognized paste adhesive.	Paste adhesive with MIL-A-46146B. Suitable for polycarbonate substrates	Paste adhesive with MIL-A-46146B. UL recognition	Fast tack paste adhesive with MIL- A-46146B. UL recognition	Fast tack, low volatile paste adhesive with MIL-A-46146B.	
Adhesive / Seala	ınt	•	•	•	•	•	•	•	
Adhesive / Sealch Coating Encapsulant / Po									
Encapsulant / Pa	otting								
Viscosity (23°C)	Pa·s (P)	-	-	-	-	-	-	-	
Application Rate	g/min	-	180	650	-	-	-	-	
Tack Free Time	min	15	240	60	90	15	5	5	
Specific Gravity (23°C)		1.06	1.12	1.23	1.10	1.32	1.04	1.04	
Hardness		-	37	46	35	40	26	30	
Tensile Strength	MPa (psi)	2.5 (360)	5.5 (800)	4.5 (650)	2.9 (420)	2.7 (390)	1.6 (230)	1.6 (230)	
Elongation	%	560	600	250	390	260	430	350	
Adhesive Strength	MPa (psi)	1.0 (140)	1.2 (175) <sup>3</sup>	-	2.0 (290) <sup>2</sup>	2.2 (320) <sup>2</sup>	1.3 (190) <sup>2</sup>	1.3 (190) <sup>2</sup>	
Thermal Conductivity	y W/m.k	0.21	-	-	0.17	0.34	0.18	0.18	
Volume Resistivity	MΩ·m	2.5×10 <sup>7</sup>	3.0×10 <sup>7</sup>	3.0×10 <sup>7</sup>	5.0×10 <sup>7</sup>	2.0×10 <sup>6</sup>	2.0×10 <sup>7</sup>	2.0×10 <sup>7</sup>	
Dielectric Strength	kV/mm	20	20	20	22	25	22	22	
Dielectric Constant	60Hz	2.6	2.8	2.8 (100Hz)	3.0	3.1	2.9	2.9	
Dissipation Factor	60Hz	0.001	0.0026	0.001 (100Hz)	0.001	0.02	0.005	0.005	
Low Molecular Siloxane (D.	3-D <sub>10</sub> ) wt%	-	-	-	-	-	-	0.028	
Flame Retardancy			UL94 HB	UL94 V-0		UL94 V-0	UL94 HB		
Low Volatility		•						•	
Temperature Resistar	ice								
Thermally Conductiv	е								
FDA									
Electro-Conductivity									
MIL-Spec <sup>4</sup>			MIL-A-46146 <sup>6</sup>		MIL-A-46146B <sup>5</sup>	MIL-A-46146B <sup>5</sup>	MIL-A-46146B <sup>5</sup>	MIL-A-46146B <sup>5</sup>	
White					0	0	0	0	
Clear							0	0	
Clear Black		•		•					
Gray			•			•	•		
2.8fl oz (83ml) tu	be		•						
100g tube					•				
130g tube						•			
150g tube									
270a tuba						•			
230g tube 10.1fl oz. (299ml 333ml cart.	) cart.		•	•					
333ml cart.					•	•			
18kg pail		•			-				
20kg pail		-				•			
5 gal. (18.9 ltr) po	ail		•	•					
55 gal. (208.2 ltr)				•					
33 gai. (200.2 lti)	a. a. ii			_					

<sup>&</sup>lt;sup>2</sup>AL-AL Lap Shear Adhesion test methods, laboratory conditions, procedures, frequency and sampling. 5MIL-A-46146B corrosion test

<sup>&</sup>lt;sup>3</sup> PBT Lap Shear Adhesion <sup>4</sup>Testing is performed in accordance with current GE - Advanced Materials quality  $^6 \mathrm{MIL}\text{-A-46146}$  physical requirements

	I	I	I				I	I
TSE3940	TSE3941	TSE3945	TSE3946	XE11-B5320	XE16-508	TSE3853-W	TSE3971	TSE3976-B
Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy
Non-Flowable	Non-Flowable	Non-Flowable	Non-Flowable	Non-Flowable	Non-Flowable	Semi-Flowable	Flowable	Flowable
Fast tack paste adhesive with MIL- A-46146B. UL recognition	Fast tack, thermally conductive paste adhesive with MIL-A- 46146B. UL recognition	Fast tack, low volatile paste adhesive with MIL-A-46146B. UL recognition	Fast tack, low volatile, thermally conductive paste adhesive with MIL- A-46146B. UL recognition	Fast tack, low volatile, thermally conductive paste adhesive.	Electro-Conductive paste adhesive	Flowable adhesive / sealant with MIL- A-46146B. UL recognition	Flowable adhesive / sealant with MIL-A- 46146B	Flowable, high-temperature resistant low volatile adhesive / sealant with MIL- A-46146B. UL recognition
	•	•	•	•		•	•	•
							•	•
-	-	-	-	-	-	400 (4000) <sup>1</sup>	100 (1000) <sup>1</sup>	100 (1000) <sup>1</sup>
-	-	-	-	-	-	-	-	-
5	5	5	5	5	60	15	10	5
1.49	1.65	1.45	1.70	2.59	1.08	1.31	1.04	1.08
40	65	51	68	80	53	34	16	30
2.9 (420)	2.9 (420)	2.9 (420)	3.9 (565)	3.6 (520)	2.7 (390)	2.3 (335)	1.5 (220)	1.7 (245)
200	100	200	100	40	170	270	350	210
1.6 (230) <sup>2</sup>	1.4 (205) <sup>2</sup>	1.5 (220) <sup>2</sup>	1.6 (230) <sup>2</sup>	1.3 (190) <sup>2</sup>	1.3 (190) <sup>2</sup>	1.3 (190) <sup>2</sup>	1.1 (160)2	1.3 (190) <sup>2</sup>
0.41	0.83	0.34	0.83	1.3	-	0.34	0.18	0.18
6.0×10 <sup>6</sup>	4.0×10 <sup>6</sup>	1.0×10 <sup>7</sup>	4.0×10 <sup>6</sup>	2.0×10 <sup>7</sup>	1.5×10 <sup>-7</sup>	2.0×10 <sup>6</sup>	2.0×10 <sup>7</sup>	1.0×10 <sup>7</sup>
21	22	22	23	17	-	20	21	20
4.5	4.0	4.5	4.0	2.6	-	3.1	2.9	3.5
0.05	0.04	0.05	0.04	0.005	-	0.02	0.005	0.01
-	-	0.025	0.025	0.020	-	-	-	0.025
UL94 V-0	UL94 V-1	UL94 V-0	UL94 V-1			UL94 V-0		UL94 HB
		•	•	•				•
								•
	•		•	•				
					•			
MIL-A-46146B <sup>5</sup>	MIL-A-46146B <sup>5</sup>	MIL-A-46146B <sup>5</sup>	MIL-A-46146B <sup>5</sup>			MIL-A-46146B <sup>5</sup>	MIL-A-46146B <sup>5</sup>	MIL-A-46146B <sup>5</sup>
	0		0	0		0	0	
					•		•	•
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	<u> </u>	I	<u> </u>	<u> </u>		<u> </u>	<u> </u>	

Typical property data values should not be used as specifications

Properties		XE11-A5133S	TSE3944	TSE3941M	TSE397	TSE3972	RTV160	TSE3975	
Cure Chemistry		Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy	
Flowability		Flowable	Semi-Flowable	Flowable	Flowable	Flowable	Flowable	Flowable	
Features and Benefits		Flowable, low volatile thermally conductive potting / coating material with MIL-A-46146B. UL recognition	Flowable low volatile adhesive / sealant with MIL-A-46146B. UL recognition	Fast tack, thermally conductive flowable adhesive / sealant with MIL-A-46146B	Flowable adhesive / sealant with MIL-A- 46146B	Fast tack, flowable adhesive / sealant with MIL-A-46146B	Flowable adhesive with UL recognition	Flowable low volatile adhesive / sealant with MIL-A-46146B	
Adhesive / Sealan	t		•	•	•	•		•	
Adhesive / Sealan Coating Encapsulant / Pot		•	•	•	•	•	•	•	
Encapsulant / Pot	ting	•					•		
Viscosity (23°C)		60 (600) <sup>1</sup>	50 (500) <sup>1</sup>	50 (500) <sup>1</sup>	50 (500) <sup>1</sup>	50 (500) <sup>1</sup>	38 (380) <sup>2</sup>	33 (330) <sup>1</sup>	
Application Rate	Pa·s (P)	-	-	-	-	-	-	-	
Tack Free Time	g/min	10	5	5	10	5	240	10	
Specific Gravity (23°C)	min	1.64	1.31	1.64	1.04	1.04	1.04	1.05	
Hardness		63	38	63	13	15	25	25	
Tensile Strength		3.9 (565)	1.5 (220)	3.2 (465)	1.2 (175)	1.3 (190)	1.9 (275)	1.2 (175)	
Elongation	MPa (psi)	100	170	70	360	350	230	220	
Adhesive Strength	%	1.3 (190) <sup>2</sup>	1.0 (145) <sup>3</sup>	1.4 (205) <sup>3</sup>	1.0 (145) <sup>3</sup>	1.0 (145) <sup>3</sup>	-	1.2 (175) <sup>3</sup>	
Thermal Conductivity	MPa (psi)	0.83	0.36	0.83	0.18	0.18	-	0.21	
Volume Resistivity	W/m.k	4.0×10 <sup>6</sup>	1.0×10 <sup>7</sup>	4.0×10 <sup>6</sup>	2.0×10 <sup>7</sup>	2.0×10 <sup>7</sup>	4.0×10 <sup>6</sup>	2.0×10 <sup>7</sup>	
Dielectric Strength	MΩ·m	20	22	21	22	21	20	23	
Dielectric Constant	kV/mm	4.0	3.8	4.0	2.9	2.9	2.8	2.9	
Dissipation Factor	60Hz	0.04	0.02	0.04	0.005	0.005	0.001	0.005	
Low Molecular Siloxane (D3-D	10) 60Hz	0.025	0.028	-	-	-	-	0.028	
Flame Retardancy	wt%	UL94 V-1	UL94 V-0		UL94 HB		UL94 HB		
Low Volatility		•	•					•	
Temperature Resistanc	е								
Thermally Conductive		•		•					
FDA									
Electro-Conductivity									
MIL-Spec <sup>5</sup>		MIL-A-46146B <sup>5</sup>	MIL-A-46146B <sup>6</sup>	MIL-A-46146B <sup>6</sup>	MIL-A-46146B <sup>6</sup>	MIL-A-46146B <sup>6</sup>		MIL-A-46146B <sup>6</sup>	
White		0	0	0	0		0	0	
Clear					0	0		0	
Black					•			•	
Gray			•						
Red									
100g Tube						•		•	
150g Tube		•		•					
10.1fl oz. (299ml) (	cart.						•		
333ml cart.		•		•		•		•	
333ml cart. 18kg pail 20kg pail									
20kg pail				•					
5 gal. (18.9 ltr) pai							•		
55 gal. (208.2 ltr) c	Irum						•		
See Page 32 for d	etails		•		•				

 $<sup>^1</sup>$ JIS K 6249  $^2$ ASTM D2196  $^3$ AL-AL Lap Shear Adhesion  $^4$ PBT Lap Shear Adhesion Materials quality test methods, laboratory conditions, procedures, frequency and sampling.

 $<sup>^5\</sup>text{Testing}$  is performed in accordance with current GE - Advanced  $^6\text{MIL-A-}46146\text{B}$  corrosion test

TSE398	TSE3996	TSE399	TSE3991	TSE3995	ECS0600	ECS0601	TSE382	TSE3826
Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy	Alkoxy	Oxime	Oxime
Flowable	Flowable	Flowable	Flowable	Flowable	Flowable	Flowable	Non-Flowable	Non-Flowabl
Flowable adhesive / sealant with MIL-A- 46146B	Low viscosity, low volatile potting and coating material with MIL-A-46146B	Potting and coating material with MIL-A- 46146B	Low viscosity potting and coating material with MIL-A-46146B	Low volatile potting and coating material with MIL-A-46146B	High-purity electrode coating material with fast tack performance. Repairable type	High-purity electrode coating material with fast tack performance	General purpose paste adhesive. UL recognition	High temperature resistant paste adhesive
							•	
•	•	•	•	•	•			
•	•	•	•	•				
17 (170) <sup>1</sup>	17 (170) <sup>1</sup>	2.5 (25) <sup>1</sup>	1.5 (15) <sup>1</sup>	2.5 (25) <sup>1</sup>	5.8 (58) <sup>1</sup>	1.4 (14) <sup>1</sup>	-	-
-	-	-	-	-	-	-	-	-
10	10	10	10	10	7	7	10	10
1.04	1.03	1.04	1.03	1.04	1.02	1.01	1.04	1.04
14	23	25	19	25	20	25	28	29
1.3 (190)	1.2 (175)	1.3 (190)	0.7 (100)	1.3 (190)	1.2 (175)	0.8 (115)	1.9 (275)	2.0 (290)
230	150	140	150	140	450	150	380	400
0.7 (100)3	0.3 (45)3	0.3 (45)3	0.2 (30)3	0.5 (75) <sup>3</sup>	-	0.3 (45) <sup>3</sup>	1.7 (245) <sup>3</sup>	1.4 (205) <sup>3</sup>
0.18	0.18	0.18	0.18	0.18	-	-	0.18	0.18
2.0×10 <sup>7</sup>	2.0×10 <sup>7</sup>	2.0×10 <sup>7</sup>	2.0×10 <sup>7</sup>	2.0×10 <sup>7</sup>	4.0×10 <sup>7</sup>	2.0×10 <sup>7</sup>	1.0×10 <sup>7</sup>	1.0×10 <sup>7</sup>
23	23	20	18	23	20	20	23	23
3.0	2.9	2.9	2.9	2.9	2.8	2.6	2.9	2.9
0.01	0.005	0.005	0.005	0.005	0.001	0.002	0.004	0.004
-	0.028	-	-	0.028	0.01	0.01	-	-
						UL94 HB	UL94 HB	
	•			•	•	•		
	_			_	_			•
MIL-A-46146B <sup>6</sup>	MIL-A-46146B <sup>6</sup>	MIL-A-46146B <sup>6</sup>	MIL-A-46146B <sup>6</sup>	MIL-A-46146B <sup>6</sup>				
0	0	0	0	0	0	0	0	
0	0	0	0	0			0	
	•	•	•	•		•	•	
							•	
								•
					•			
•	•	•	•	•		•	•	

Typical property data values should not be used as specifications

	Properties		TSE384-B	TSE3878	TSE3840-G	TSE3843-W	TSE3877-B	TSE387	TSE388	
Cur	e Chemistry		Oxime	Oxime	Oxime	Oxime	Oxime	Oxime	Oxime	
Flov	vability		Non-Flowable	Non-Flowable	Semi-Flowable	Semi-Flowable	Flowable	Flowable	Flowable	
Fea	tures and Benefits		General purpose paste adhesive. UL recognition	High temperature resistant paste adhesive	UL recognized semi- flowable adhesive / sealant.	General purpose flowable adhesive / sealant. UL recognition	General purpose flowable adhesive / sealant. UL recognition	General purpose flowable adhesive / sealant.	General purpose flowable adhesive / sealant.	
App	Adhesive / Sealant		•	•	•	•	•	•	•	
Application	Coating							•	•	
tion	Encapsulant / Potti	ng								
Visc	cosity (23°C)	Pa·s (P)	-	-	-	500 (5000) <sup>1</sup>	300 (3000) <sup>1</sup>	60 (600) <sup>1</sup>	10 (100) <sup>1</sup>	
App	lication Rate	g/min	-	-	-	-	-	-	-	
Tac	k Free Time	min	60	20	30	60	20	90	60	
Spe	cific Gravity (23°C)		1.46	1.05	1.40	1.57	1.08	1.03	1.04	
Har	dness		50	29	31	60	25	25	16	
Ten	sile Strength	MPa (psi)	2.9 (421)	1.9 (275)	2.4 (350)	3.9 (565)	2.0 (290)	2.3 (335)	1.5 (220)	
Elor	ngation	%	270	360	270	130	440	350	330	
Adh	esive Strength	MPa (psi)	1.4 (203) <sup>2</sup>	1.0 (145) <sup>2</sup>	1.5 (220) <sup>2</sup>	1.8 (260) <sup>2</sup>	2.0 (290) <sup>2</sup>	1.3 (190) <sup>2</sup>	1.3 (190) <sup>2</sup>	
The	rmal Conductivity	W/m.k	0.59	-	0.25	0.67	0.18	0.18	0.18	
Volu	ume Resistivity	MΩ·m	1.0×10 <sup>7</sup>	1.0×10 <sup>7</sup>	1.0×10 <sup>7</sup>	1.0×10 <sup>7</sup>	1.0×10 <sup>7</sup>	1.0×10 <sup>7</sup>	1.0×10 <sup>7</sup>	
Diel	ectric Strength	kV/mm	22	20	22	21	20	20	20	
Diel	ectric Constant	60Hz	4.0	3.1	4.0	3.9	3.5	2.9	2.8	
Diss	sipation Factor	60Hz	0.016	0.005	0.02	0.02	0.01	0.004	0.008	
Low	Molecular Siloxane (D3-D10	) wt%	-	-	-	-	-	-	-	
Flar	me Retardancy		UL94 V-0		UL94 V-0	UL94 V-1				
Low	/ Volatility									
Tem	perature Resistance			•			•			
The	rmally Conductive					•				
FDA	4									
Elec	ctro-Conductivity									
MIL.	-Spec <sup>4</sup>									
	White					0		0	0	
	Clear							0		
00	Black		•	•			•	•		
Color	Gray				•				•	
	Red									
	Aluminum									
	2.8fl oz. (83ml) tube	)								
	100g tube						•			
	140g tube									
	150g tube		•			•				
	5.4fl. oz. (160ml) ca	rt.								
Pac	250g tube					•				
Packaging	10.1fl oz. (299ml) co	art.								
jing	10.3fl oz. (305ml) tu	ibe								
	333ml cart.		•	•	•	•	•			
	18kg pail						•			
	5 gal. (18.9 litr) pail									
	55 gal. (208.2 ltr) dr									
	See Page 32 for de									

<sup>&</sup>lt;sup>1</sup>JIS K 6249 <sup>2</sup>AL-AL Lap Shear Adhesion <sup>3</sup> PBT Lap Shear Adhesion <sup>4</sup>Testing is performed in accordance with current GE - Advanced Materials quality test methods, laboratory conditions, procedures, frequency and sampling <sup>5</sup>MIL-A-46146 Group I Type I general purpose paste <sup>6</sup>MIL-A-46146 Group III Type I high temperature paste 17

TSE389	FRV1106	RTV157	RTV159	RTV100 series	RTV106	IS800 series	IS806	TSE370
Oxime	Acetoxy	Acetoxy	Acetoxy	Acetoxy	Acetoxy	Acetoxy	Acetoxy	Acetoxy
Flowable	Non-Flowable	Non-Flowable	Non-Flowable	Non-Flowable	Non-Flowable	Non-Flowable	Non-Flowable	Non-Flowable
Flowable sealant / coating material. UL recognition	Fluorosilicone with high temperature performance. Excellent fuel, oil, moisture, UV, ozone & chemical resistance	High strength paste adhesive	High temperature, high strength, paste adhesive	Paste adhesive with FDA, USDA, NSF, MIL-A-46106, MIL-S-47162, MIL-S-14112 and UL recognition	High temperature resistant paste adhesive. FDA, USDA, NSF, MIL-A-46106.	Paste adhesive with FDA, USDA, NSF and UL recognition	High temperature, paste adhesive. FDA, USDA, NSF, UL recognition	Fast tack paste adhesive
	•	•	•	•	•	•	•	•
•								
5.6 (56) <sup>1</sup>	-	-	-	-	-	-	-	-
-	88	155	175	400	400	410	440	-
30	20	45	45	20	20	30	30	5
1.04	1.58	1.09	1.09	1.05	1.07	1.04	1.05	1.04
30	42	28	20	30	30	23	22	22
2.0 (290)	3.33 (485)	6.2 (900)	7.0 (1,025)	2.75 (400)	2.55 (370)	2.06 (300)	1.67 (240)	2.5 (365)
200	230	825	350	450	400	450	425	530
1.8 (260) <sup>2</sup>	-	1.3 (183) <sup>3</sup>	-	1.4 (200) <sup>2</sup>	1.4 (200) <sup>2</sup>	1.0 (150) <sup>2</sup>	-	2.2 (320) <sup>2</sup>
0.18	-	-	-	-	-	-	-	0.18
1.0×10 <sup>7</sup>	-	7.5×10 <sup>6</sup>	1.1×10 <sup>7</sup>	3.0×10 <sup>7</sup>	3.0×10 <sup>6</sup>	-	-	1.0×10 <sup>7</sup>
20	13.7	20.7	19.7	20	20	20	19.5	22
2.7	6.3 (1000Hz)	2.9	2.6	2.8	2.8	2.9	2.9	3.0
0.009	-	0.0009	0.0007	0.001	0.001	-	-	0.003
-	-	-	-	-	-	-	-	-
UL94 HB						UL94 HB	UL94 HB	
	•		•		•		•	
				•	•	•	•	
				MIL-A-46146 <sup>5</sup>	MIL-A-46146 <sup>6</sup>			
0				RTV102		IS802		0
0				RTV108		IS808		0
•				RTV103		IS803		•
		•						
	•		•		•		•	
				RTV109		IS800.09		
		•	•	•	•	•		
	•	•	•		•			
				•	•	•	•	
				•	•			
		•	•	•	•	•	•	
				•	•	•	•	

Features and Benefits		Properties		IS5628E	RTV116	RTV110 series
Features and Benefits    High strength flowable adhesive / sealant   High temperature resistant, flowable adhesive / sealant   High temperature resistant, flowable adhesive. Na. NSF. MIL.A-476106.	Cur	e Chemistry		Acetoxy	Acetoxy	Acetoxy
Features and Benefits	Flov	vability		Flowable	Flowable	Flowable
Viscosity (23°C)         Pas (P)         175 (1,750)         25 (250) 1         20 (200) 1           Application Rate         g/min         -         -         -           Tack Free Time         min         10         30         20           Specific Gravity (23°C)         1.10         1.09         1.05           Hardness         33         20         25           Tensile Strength         MPa (psi)         7.5 (1085)         2.45 (355)         2.20 (320)           Elongation         %         750         350         325           Adhesive Strength         MPa (psi)         -         0.9 (125)²         0.7 (100)²           Thermal Conductivity         W/mk         -         -         -           Volume Resistivity         MΩm         -         2.0x106         6.0x106           Dielectric Strength         kV/mm         -         16         16           Dielectric Constant         60Hz         -         2.8         2.8           Dissipation Factor         60Hz         -         0.001         0.001           Low Molecular Siloxane (Dp-Dia) wt%         -         -         -           Flame Retardancy         -         -         -		tures and Benefits		flowable adhesive /	flowable adhesive. FDA, USDA, NSF, MIL-A-47040,	Flowable adhesive with FDA, USDA, NSF, MIL-A-46106.
Viscosity I23°CI         Pas (P)         175 (1,750)         25 (250) ¹         20 (200) ¹           Application Rate         g/min         -         -         -           Tack Free Time         min         10         30         20           Specific Gravity I23°CI         1.10         1.09         1.05           Hardness         33         20         25           Tensile Strength         MPa (psil)         7.5 (1085)         2.45 (355)         2.20 (320)           Elongation         %         750         350         325           Adhesive Strength         MPa (psil)         -         0.9 (125)²         0.7 (100)²           Thermal Conductivity         W/m*k         -         -         -           Volume Resistivity         MΩm         -         2.0x106         6.0x106           Dielectric Strength         kV/mm         -         16         16           Dielectric Constant         60Hz         -         2.8         2.8           Dissipation Factor         60Hz         -         0.001         0.001           Low Molecular Siloxane (D)-Drail         -         -         -         -           Flame Retardancy         -         -	App	Adhesive / Sealant		•	•	
Viscosity I23°CI         Pas (P)         175 (1,750)         25 (250) ¹         20 (200) ¹           Application Rate         g/min         -         -         -           Tack Free Time         min         10         30         20           Specific Gravity I23°CI         1.10         1.09         1.05           Hardness         33         20         25           Tensile Strength         MPa (psi)         7.5 (1085)         2.45 (355)         2.20 (320)           Elongation         %         750         350         325           Adhesive Strength         MPa (psi)         -         0.9 (125)²         0.7 (100)²           Thermal Conductivity         W/mk         -         -         -           Volume Resistivity         MΩm         -         2.0x106         6.0x106           Dielectric Strength         kV/mm         -         16         16           Dielectric Constant         60Hz         -         2.8         2.8           Dissipation Factor         60Hz         -         0.001         0.001           Low Molecular Siloxane (Dx-Dua) wt%         -         -         -           Flame Retardancy         -         -         - </td <td>lica</td> <td>Coating</td> <td></td> <td></td> <td></td> <td>•</td>	lica	Coating				•
Application Rate g/min	tion	Encapsulant / Potti	ng		•	•
Tack Free Time	Visc	cosity (23°C)	Pa·s (P)	175 (1,750)	25 (250) <sup>1</sup>	20 (200) <sup>1</sup>
Specific Gravity (23°C)	App	lication Rate	g/min	-	-	-
Hardness   33   20   25	Tac	k Free Time	min	10	30	20
Tensile Strength MPa (psil 7.5 (1085) 2.45 (355) 2.20 (320)  Elongation % 750 350 325  Adhesive Strength MPa (psil - 0.9 (125)² 0.7 (100)²  Thermal Conductivity W/m-k	Spe	cific Gravity (23°C)		1.10	1.09	1.05
Elongation	Har	dness		33	20	25
Adhesive Strength MPa (psi) - 0.9 (125)² 0.7 (100)²  Thermal Conductivity W/m⋅k	Ten	sile Strength	MPa (psi)	7.5 (1085)	2.45 (355)	2.20 (320)
Thermal Conductivity W/m⋅k	Elor	ngation	%	750	350	325
Volume Resistivity         MΩ·m         -         2.0x10 <sup>6</sup> 6.0x10 <sup>6</sup> Dielectric Strength         kV/mm         -         16         16           Dielectric Constant         60Hz         -         2.8         2.8           Dissipation Factor         60Hz         -         0.001         0.001           Low Molecular Siloxane (D₂-D₂a) wt%         -         -         -           Flame Retardancy         Low Volatility         -         -         -           Temperature Resistance         •         •         -         -           Thermally Conductive         FDA         •         •         •           Electro-Conductivity         MIL-A-46146 <sup>4</sup> •         •           White         RTV112         RTV112         RTV118           Red         •         •         •         •           2.8fl oz. (83ml) tube         •         •         •         •           10.3fl oz. (305ml) tube         •         •         •         •           2.8fl oz. (18.9 ltr) pail         •         •         •         •	Adh	esive Strength	MPa (psi)	-	0.9 (125) <sup>2</sup>	0.7 (100)2
Dielectric Strength kV/mm - 16 16  Dielectric Constant 60Hz - 2.8 2.8  Dissipation Factor 60Hz - 0.001 0.001  Low Molecular Siloxane (D3-D10) wt%  Flame Retardancy  Low Volatility  Temperature Resistance  Thermally Conductive  FDA  Electro-Conductivity  MIL-Spec³ MIL-A-46146⁴  White Clear O RTV112  Red  2.8fl oz. (83ml) tube  10.3fl oz. (305ml) tube  310ml cart.  5 gal. (18.9 ltr) pail	The	rmal Conductivity	W/m-k	-	-	-
Dielectric Constant   60Hz   -   2.8   2.8     Dissipation Factor   60Hz   -   0.001   0.001     Low Molecular Siloxane (D3-D10) wt%   -   -   -     Flame Retardancy     Low Volatility   Temperature Resistance       Thermally Conductive     FDA           Electro-Conductivity       MIL-Spec³     MIL-A-46146⁴     White               Clear                 Red               2.8fl oz. (83ml) tube           10.3fl oz. (305ml) tube         The substituting         The substituting	Volu	ume Resistivity	MΩ·m	-	2.0×10 <sup>6</sup>	6.0×10 <sup>6</sup>
Dissipation Factor	Diel	ectric Strength	kV/mm	-	16	16
Low Molecular Siloxane (D3-D10) wt%	Diel	ectric Constant	60Hz	-	2.8	2.8
Flame Retardancy Low Volatility Temperature Resistance Thermally Conductive FDA Electro-Conductivity MIL-Spec³ White Clear Red  2.8fl oz. (83ml) tube 10.3fl oz. (305ml) tube 310ml cart. 5 gal. (18.9 ltr) pail	Diss	sipation Factor	60Hz	-	0.001	0.001
Low Volatility Temperature Resistance Thermally Conductive  FDA  Electro-Conductivity  MIL-Spec³  White Clear Red  2.8fl oz. (83ml) tube 10.3fl oz. (305ml) tube 310ml cart. 5 gal. (18.9 ltr) pail	Low	Molecular Siloxane (D3-D10	) wt%	-	-	-
Temperature Resistance Thermally Conductive  FDA  Electro-Conductivity  MIL-Spec³  White  Clear  Red  2.8fl oz. (83ml) tube 10.3fl oz. (305ml) tube 310ml cart.  5 gal. (18.9 ltr) pail	Flar	ne Retardancy				
Thermally Conductive  FDA  Electro-Conductivity  MIL-Spec³  White  Clear  Red  2.8fl oz. (83ml) tube 10.3fl oz. (305ml) tube 310ml cart.  5 gal. (18.9 ltr) pail	Low	/ Volatility				
FDA	Tem	perature Resistance			•	
Electro-Conductivity  MIL-Spec <sup>3</sup> White  Clear  Red  2.8fl oz. (83ml) tube 10.3fl oz. (305ml) tube 310ml cart.  5 gal. (18.9 ltr) pail	The	rmally Conductive				
MIL-Spec <sup>3</sup> White  Clear  Red  2.8fl oz. (83ml) tube 10.3fl oz. (305ml) tube 310ml cart.  5 gal. (18.9 ltr) pail	FDA	1			•	•
White RTV112 Clear O RTV118 Red  2.8fl oz. (83ml) tube 10.3fl oz. (305ml) tube 310ml cart. 5 gal. (18.9 ltr) pail	Elec	ctro-Conductivity				
Clear O RTV118  Red  2.8fl oz. (83ml) tube 10.3fl oz. (305ml) tube 310ml cart. 5 gal. (18.9 ltr) pail	MIL	-Spec <sup>3</sup>				MIL-A-46146 <sup>4</sup>
Red  2.8fl oz. (83ml) tube  10.3fl oz. (305ml) tube  310ml cart.  5 gal. (18.9 ltr) pail		White				RTV112
Red  2.8fl oz. (83ml) tube  10.3fl oz. (305ml) tube  310ml cart.  5 gal. (18.9 ltr) pail	Colo	Clear		0		RTV118
10.3fl oz. (305ml) tube 310ml cart. 5 gal. (18.9 ltr) pail	_~	Red			•	
310ml cart. • 5 gal. (18.9 ltr) pail • •		2.8fl oz. (83ml) tube				•
310ml cart.		10.3fl oz. (305ml) tu	be		•	•
5 gal. (18.9 ltr) pail	Pac	310ml cart.		•		
20kg pail	;kac	5 gal. (18.9 ltr) pail			•	•
C   2009 Paii	ging	20kg pail		•		
200 ltr drum		200 ltr drum		•		
55 gal. (208.2 ltr) drum		55 gal. (208.2 ltr) dr	um		•	•

Typical property data values should not be used as specifications

 $<sup>^1</sup>$ ASTM D2196  $^2$ Al-Al Lap Shear Adhesion  $^3$ Testing is performed in accordance with current GE - Advanced Materials quality test methods, laboratory conditions, procedures, frequency and sampling.  $^4$ MIL-A-46146 Group I Type I general purpose paste

# Product Details - 1 Part Heat Cure Grades

	Properties		XE13-B3208	Addisil 8101	TSE3212	TSE322	TSE3261-G	TSE322S
Flov	vability		Non-Flowable	Non-Flowable	Semi-Flowable	Flowable	Flowable	Semi-Flowable
Fea	tures and Benefits	6	Paste adhesive / sealant	Paste adhesive with fast cure at elevated temperatures. Good storage stability	Thixotropic adhesive / sealant	Flowable adhesive / sealant	High temperature resistant flowable adhesive / sealant	Flowable adhesive / sealant. UL recognition
App	Adhesive / Seala	nt	•	•	•	•	•	•
Application	Coating							
tion	Encapsulant / Po	tting						
Visc	cosity (23°C)	Pa-s (P)	670 (6700) <sup>1</sup>	-	280 (2800) <sup>1</sup>	110 (1100) <sup>1</sup>	80 (800) <sup>1</sup>	70 (700) <sup>1</sup>
Cur	e Condition	C/h	150/1	175/0.16	150/1	150/1	150/1	150/1
Spe	cific Gravity (23°C)		1.08	1.11	1.26	1.27	1.48	1.26
Har	dness		50	43	52	45	54	37
Ten	sile Strength	MPa (psi)	4.4 (640)	9.2 (1,340)	3.7 (535)	3.4 (495)	4.9 (710)	3.6 (520)
Elor	ngation	%	430	590	240	230	160	230
Adh	esive Strength	MPa (psi)	3.7 (535) <sup>2</sup>	-	2.6 (375) <sup>2</sup>	2.5 (365) <sup>2</sup>	1.8 (260) <sup>2</sup>	2.5 (365) <sup>2</sup>
The	rmal Conductivity	W/m.k	0.20	-	0.29	0.29	0.41	0.29
Volu	ume Resistivity	MΩ·m	1.0×10 <sup>7</sup>	-	2.0×10 <sup>7</sup>	2.0×10 <sup>7</sup>	2.0×10 <sup>7</sup>	1.0×10 <sup>7</sup>
Diel	ectric Strength	kV/mm	23	24.4	20	20	22	25
Diel	ectric Constant	60Hz	3.1	2.99 (50Hz)	3.2	3.1	3.3	3.1
Diss	sipation Factor	60Hz	0.001	0.002 (50Hz)	0.001	0.006	0.02	0.006
Flar	me Retardancy							UL94 HB
Ten	nperature Resistar	nce		•			•	
The	rmally Conductive	9						
	White				0			
	Clear		0					
Color	Black					•		
	Gray			•			•	
	Blue					•		•
	100g tube				•	•		
	310ml cart.			•				
Pac	333ml cart.				•	•		•
Packaging	1kg can				•	•		•
ing	1.5kg can						•	
	18kg pail		•	•				
	20kg pail					•		

 $<sup>^{1}</sup>$ JIS K 6249  $^{2}$ AL-AL Lap Shear Adhesion

Typical property data values should not be used as specifications

# Product Details - 1 Part Heat Cure Grades

	Properties	TSE3280-G	TSE3281-G	TSE3221S	TSE326	TSE3260	TSE3282-G	TSE326M <sup>4</sup>	
Flov	vability	Flowable	Flowable	Flowable	Flowable	Flowable	Flowable	Flowable	
Feat	tures and Benefits	Thermally conductive flowable adhesive	Thermally conductive flowable adhesive	Flowable adhesive / sealant, coating material	High temperature resistant flowable adhesive. UL recognition	High temperature resistant flowable adhesive. UL recognition	Thermally conductive flowable adhesive	High temperature resistant flowable adhesive.	
App	Adhesive / Sealant	•	•	•	•	•	•	•	
Application	Coating			•					
tion	Encapsulant / Potting								
Visc	Osity (23°C) Pa·s (P)	60 (600) <sup>1</sup>	60 (600) <sup>1</sup>	58 (580) <sup>1</sup>	28 (280) <sup>1</sup>	23 (230) <sup>1</sup>	20 (200) 1	16 (160) <sup>1</sup>	
Cure	e Condition c/h	150/1	150/1	150/1	150/1	150/1	150/1	200/0.5	
Spec	cific Gravity (23°C)	2.10	2.70	1.03	1.45	1.34	2.70	1.46	
Har	dness	62	84	28	43	35	80	38	
Tens	sile Strength MPa (psi)	3.2 (465)	4.5 (655)	2.8 (405)	3.4 (495)	1.7 (245)	4.0 (580)	2.9 (420)	
Elon	ngation %	110	50	370	170	250	50	180	
Adh	esive Strength MPa (psi)	2.0 (290)3	2.5 (365) <sup>3</sup>	2.5 (365) <sup>3</sup>	2.0 (290) <sup>3</sup>	0.5 (75) <sup>3</sup>	2.5 (365) <sup>3</sup>	1.5 (220) <sup>3</sup>	
Ther	rmal Conductivity W/m.k	0.88	1.68	0.18	0.41	0.18	2.0	0.41	
Volu	ıme Resistivity ΜΩ·m	2.5×10 <sup>6</sup>	4.8×10 <sup>6</sup>	6.0×10 <sup>7</sup>	2.0×10 <sup>7</sup>	1.0×10 <sup>7</sup>	4.8×10 <sup>6</sup>	2.0×10 <sup>7</sup>	
Diele	ectric Strength kV/mm	21	15	23	22	25	23	22	
Diele	ectric Constant 60Hz	4.3	5.2	2.8	3.3	3.1	5.5	3.3	
Diss	ipation Factor 60Hz	0.002	0.002	0.001	0.02	0.01	0.001	0.02	
Flan	ne Retardancy				UL94 HB	UL94 HB			
Tem	perature Resistance				•	•		•	
Ther	rmally Conductive	•	•				•		
	White								
	Clear			0					
Color	Black								
9	Gray	•	•				•		
	Red				•	•		•	
	100g tube			•					
	140g tube				•				
	200g tube	•					•		
	333ml cart.	•		•	•			•	
	1 pint (473ml)								
Ę	1kg can		•	•	•	•	•	•	
ack	2kg can	•							
Packaging	4kg can								
ng	1 gal. (3.8 ltr) can								
	18kg pail			•					
	20kg pail					•			
	5 gal. (18.9 ltr) pail								
	180kg drum			•					
	55 gal. (208.2 ltr) drum								

<sup>&</sup>lt;sup>1</sup>JIS K 6249 <sup>2</sup>ASTM D2196 <sup>3</sup>AL-AL Lap Shear Adhesion <sup>4</sup>TSE325M EX in Europe and the Americas

TSE3253 TSE3251		TSE3251-C	TSE325	TSE3252	TSE325-B	TSE3250	ECC4865
Semi-Flowable	Semi-Flowable	Semi-Flowable	Flowable	Semi-Flowable	Flowable	Flowable	Flowable
Flowable potting / coating material. UL recognition	Flowable coating material	Flowable coating material	Flowable potting / coating material	Flowable coating material	Flowable potting / coating material	Flowable potting / coating material	Low viscosity conformal coating with UV tracer, fast thermal cure & outstanding long-term viscosity stability
•	•	•	•	•	•	•	•
•			•		•	•	
14 (140) <sup>1</sup>	8.5 (85) <sup>1</sup>	7.0 (70) <sup>1</sup>	4.0 (40) <sup>1</sup>	4.0 (40) <sup>1</sup>	3.5 (35) <sup>1</sup>	1.3 (13) <sup>1</sup>	0.25 (2.5) 2
150/1	150/1	150/1	150/1	150/1	150/1	150/1	-
1.22	1.02	1.02	1.02	1.00	1.02	0.97	1.19
30	16	16	12	21	20	9	35
2.9 (420)	0.7 (100)	0.7 (100)	0.7 (100)	-	0.9 (130)	-	-
200	200	200	200	-	200	-	-
1.0 (145) <sup>3</sup>	0.4 (60) <sup>3</sup>	0.4 (60) <sup>3</sup>	0.4 (60) <sup>3</sup>	0.4 (60) <sup>3</sup>	0.4 (60)3	0.1 (15) <sup>3</sup>	-
0.18	0.18	0.18	0.18	0.17	0.18	0.17	-
7.0×10 <sup>7</sup>	2.0×10 <sup>7</sup>	2.0×10 <sup>7</sup>	2.0×10 <sup>7</sup>	2.0×10 <sup>7</sup>	2.0×10 <sup>7</sup>	2.0×10 <sup>7</sup>	-
23	20	20	21	20	21	21	20
3.0	2.8	2.8	2.9	2.8	2.9	2.8	2.4
0.004	0.002	0.001	0.001	0.001	0.001	0.001	0.01
UL94 V-1							
	0		0	0			
		0				0	0
•					•		
		•					
							•
•	•	•	•	•	•	•	
			•				
							•
			•				
							•
							•

Typical property data values should not be used as specifications

# Product Details - 2 Part Room Temperature Cure Grades

	Properties		RTV	223	RTV	577	RT\	/88	RTV	/60	RTV	8262	RTV	566	RT\	/41	
Con	nponents			RTV223 (B)		DBT	RTV88	DBT	RTV60	DBT	RTV8262	RTV9858		RTV566 (B)	RTV41	DBT	
	vability		Non-Fl		Non-Flo		Semi-Fl		Flow			able	Flow		Flow		
	tures and Benefits	5	Fast RT of strength offering flo		Low tem resistar sealant wit	perature it paste h excellent	Temperatur semi-flowal Excellen	re resistant,	Tempe resistant sealant with release ca	rature flowable h excellent	High tempera sealant. M	ature, flowable L-S-23586E e. Excellent apabilities	Low volati gassing seal and High te	le, low out ant with Low	Sealar FDA con Excellen prope	nt with npliance. t release	
Application	Adhesive / Sealar Coating	nt															
ation	Encapsulant / Po	ttina															
	ing Ratio ((A):(B) by wei		12	2:1	100	):0.5	100	):0.5	100	:0.5	10	0:5	100	):0.1	100	):0.5	
	Or (mixed)		Gr	au	Wh	ite	Re	ed	Re			ed	Re		Wh	nite	
Visc	osity (mixed) (23°C)	Pa·s (P)		<u> </u>	700 (7			8800) <sup>2</sup>	47 (4			170) <sup>2</sup>		30) <sup>2</sup>		90) <sup>2</sup>	
	Life (23°C)	h		-	á		0.		2			2	1			L	
	k Free Time	min	(	5		_		_	_			_		-		-	
Cure	e Condition	C/h	25	5/8	25,	/24	25	/24	25/	/24	25	/24	25	/24	25,	/24	
Spe	cific Gravity (23°C)		1.3	35	1.3	35	1.4	47	1.4	48	1.	47	1.4	49	1.3	31	
Har	dness		3	6	4	8	5	8	5	7	5	2	6	1	4	7	
Ten	sile Strength	MPa (psi)	1.6 (	235)	3.0 (	440)	5.8 (	840)	6.9 (	995)	4.0 (	585)	5.5 (	795)	3.6 (	520)	
	ngation	%	22	13	15	50	12	20	12	20	1:	50	12	20	19	90	
Adh	esive Strength	MPa (psi)	0.73	(105)		-		-	_			-	3.2 (	465) <sup>3</sup>		-	
The	rmal Conductivity	W/m.k		-	0.3	31	0	31	0.3	31	0.	31	0.3	31	0.3	31	
Volu	ume Resistivity	MΩ·m		-	5.6>	10 <sup>6</sup>	2.8>	₹10 <sup>6</sup>	4.4x	:10 <sup>6</sup>	4.4	≺10 <sup>6</sup>	2.0>	⟨10 <sup>6</sup>	1.6	≺10 <sup>6</sup>	
Diel	ectric Strength	kV/mm		-	18	3.5	17	<sup>7</sup> .4	17	7.7	18	3.5	21	2	20	).3	
Diel	ectric Constant	60Hz		-	3.98 (	1kHz)	4.3 (1	lkHz)	4.0 (1	.kHz)	3.9 (	1kHz)	3.9 (1	LkHz)	3.7 (1	LkHz)	
Diss	sipation Factor	60Hz		-	0.02 (	1kHz)	0.03 (	1kHz)	0.02 (	1kHz)	0.017	(1kHz)	0.02 (	1kHz)	0.007	(1kHz)	
Flar	ne Retardancy																
Low	/ Volatility																
Tem	nperature Resistar	nce															
FDA	1																
MIL.	-Spec <sup>4</sup>										MIL-S-2	23586E⁵					
	10g bottle																
	30g bottle																
	100g bottle																
	1kg can																
	1 pint (473 ml) co	ın		•													
PC	1 gal. (3.8 ltr) pail		•	•													
Packaging	5 gal. (18.9 ltr) pa		•														
1gin(	55 gal. (208.2 ltr)	drum	•														
<u>U</u>	1 lb. (454g) Kit																
	12 lb. (5.4kg) Kit																
	13 lb. (5.9kg) Kit																
	50 lb. (22.7kg) Kit																
	55 gal. (208.2 ltr)																
	500 lb. (227kg) Ki	t															

<sup>&</sup>lt;sup>1</sup>JIS K 6249 <sup>2</sup>ASTM D2196 <sup>3</sup>AL-AL Lap Shear Adhesion <sup>4</sup>Testing is performed in accordance with current GE - Advanced Materials quality test methods, laboratory conditions, procedures, frequency and sampling. <sup>5</sup>MIL-S-23586E Type II Class 2 Grade A, <sup>6</sup>MIL-S-23586E Type I Class 2 Grade A,

 $<sup>^7</sup>$ MIL-S-23586E Type I Class 1 Grade B1

RTV560	RTV31	RTV511	RTV11	RTV8112	RTV8111	TSE350	TSE352	RTV567
RTV560 DBT	RTV31 DBT	RTV511 DBT	RTV11 DBT	RTV8112 RTV9858	RTV8111 RTV9891	TSE350 CE61	TSE352 CE61	RTV567 (A) RTV567 (B)
Flowable	Flowable	Flowable	Flowable	Flowable	Flowable	Flowable	Flowable	Flowable
Flowable sealant with Lor and High temperature performance capability. Excellent release capabiliti	resistant flowable sealant with excellen	Low temperature resistant flowable t sealant with excellent release capabilities	Sealant with Excellent release properties. FDA compliance	Flowable sealant with MIL-S-23586E compliance	Flowable sealant with MIL-S-23586E compliance	Flowable potting / encapsulant with excellent release properties	Flowable potting / encapsulant with excellent release properties	Low volatile, low temperature resistant sealant. Excellent release properties
•		•	•	•	•			•
•	•	•	•	•	•	•	•	•
100:0.5	100:0.5	100:0.5	100:0.5	100:5	100:2	100:0.5	100:0.5	100:0.1
Red	Red	White	White	White	White	Light Gray	Light Gray	Translucent
30 (300) <sup>2</sup>	25 (250) <sup>2</sup>	16 (160) <sup>2</sup>	11 (110) <sup>2</sup>	11 (110) <sup>2</sup>	9.9 (99) <sup>2</sup>	10 (100) <sup>1</sup>	9.0 (90) <sup>1</sup>	3.9 (39) <sup>2</sup>
2.25	2	1.5	1.5	2	0.5	1	1	9
-	-	-	-	-	-	-	-	-
25/24	25/24	25/24	25/24	25/24	25/24	23/72	23/72	25/7 (days)
1.42	1.42	1.21	1.19	1.19	1.18	1.18	1.19	1.00
55	54	42	41	42	45	47	43	20
4.7 (685)	5.9 (870)	2.7 (385)	2.1 (300)	2.1 (300)	2.45 (355)	2.5 (365)	2.0 (290)	-
120	170	170	160	160	160	170	180	-
-	-	-	-	-	-	-	-	-
0.31	0.31	0.26	0.29	0.29	0.29	-	-	0.29
2.0×10 <sup>6</sup>	1.6×10 <sup>6</sup>	2.0×10 <sup>6</sup>	1.1×10 <sup>7</sup>	2.7×10 <sup>7</sup>	1.0×10 <sup>7</sup>	1.0×10 <sup>6</sup>	1.0×10 <sup>6</sup>	1.1×10 <sup>7</sup>
21.2	17	20.5	20.3	18.7	19.7	22	22	20.3
3.9 (1kHz)	4.4 (1kHz)	3.6 (1kHz)	3.3 (1kHz)	4.02 (1kHz)	3.3 (1kHz)	3.1	3.1	3.3 (1kHz)
0.02 (1kHz)	0.03 (1kHz)	0.005 (1kHz)	0.006 (1kHz)	0.007 (1kHz)	0.0055 (1kHz)	0.025	0.025	0.006 (1kHz)
								•
•	•	•						•
			•					
				MIL-S-23586E <sup>6</sup>	MIL-S-23586E <sup>7</sup>			
						•	•	
						•	•	
						•	•	
•	•	•	•	•	•			
	•	•	•					
				•	•			
	•	•	•					
		_					1	

Typical property data values should not be used as specifications

# Product Details - 2 Part Room Temperature Cure Grades

	Properties		TSE	3663	TSE	3664	RT\	/12	
Comp	onents		TSE3663 (A)	TSE3663 (B)	TSE3664 (A)	TSE3664 (B)	RTV12 (A)	RTV12 (C)	
Flowal			Flow		Flow			able	
	res and Benefits		Flow encaps adhe	able sulant /	Flowable e	ncapsulant e with fast times. UL	Low visco	osity deep ring rubber olor for visual	
₽ Ad	dhesive / Sealan	t							
Application Er	oating								
g Er	Encapsulant / Potting								
Mixing	Mixing Ratio ((A):(B) by weight)		10	0:2	100	):7.5	20	D:1	
Color	Color (mixed)		Off-V	Vhite	Gr	ay	Cle	ear	
Viscos	iscosity (mixed) (23°C) Pa·s (P)		4.0 (	40) <sup>1</sup>	3.0 (	30) <sup>1</sup>	1.5 (	15) <sup>2</sup>	
Pot Lif	ot Life (23°C) h		0	.5	0	.1	1	.6	
Cure C	ure Condition C/h		23.	/72	23.	/72	23	/24	
Specif	ic Gravity (23°C)		1.:	19	1.4	41	1.0	00	
Hardn	ardness		4	2	6	5	18		
Tensile	ensile Strength MPa (psi)		1.4 (	205)	4.0 (	580)	-		
Elongo	ongation %		13	10	8	0	200		
Adhes	dhesive Strength MPa (psi)		0.9 (2	130) <sup>3</sup>	1.0 (2	145) <sup>3</sup>		-	
Therm	ermal Conductivity W/m.k		0.7	27	0.4	42	0.	17	
Volum			1.0	≺10 <sup>7</sup>	1.0	≺10 <sup>7</sup>	1.0	×10⁵	
Dielec	olume Resistivity MΩ·m electric Strength kv/mm		2	0	2	0	15.7		
Dielec	tric Constant	60Hz	3.	.1	3.	.1	3.0 (1	LkHz)	
Dissipo	ation Factor	60Hz	0.0	25	0.0	01	0.001	(1kHz)	
Flame	Retardancy				UL94	4 V-0			
Low V	olatility								
Tempe	erature Resistan	ce							
Therm	ally Conductive								
FDA									
30	Og bottle								
P 80	Og bottle								
중 50	00g bottle								
Packaging 14	kg can								
1.	6kg can								
18	3kg pail		•						
20	Okg pail								
1	lb. (454g) Kit								
42	2 lb. (19kg) Kit								
42	20 lb. (190kg) Kit								

Typical property data values should not be used as specifications  $^{1}$ JIS K 6249  $^{2}$ ASTM D2196  $^{3}$ AL-AL Lap Shear Adhesion

# Product Details - 2 Part Heat Cure Grades

Properties	· · · · · · · · · · · · · · · · · · ·	RTV658	TSE3360	LVG342	XE14-A0425	TSE3320	TSE3337
Components		RTV658 (A) RTV658 (B)	TSE3360 (A) TSE3360 (B)	LVG342 (A) LVG342 (B)	XE14-A0425 (A) XE14-A0425 (B)	TSE3320 (A) TSE3320 (B)	TSE3337 (A) TSE3337 (
Flowability		Non-Flowable	Non-Flowable	Non-Flowable	Semi-Flowable	Semi-Flowable	Flowable
Features and Benefit	:S	Fast cure paste adhesive with low volatility. Extended pot life.	General purpose paste adhesive with extended pot life.	Low volatile, paste adhesive with excellent compression set and CSR properties	High temperature resistant paste adhesive with thermal conductive performance.	Flowable paste adhesive with thermal conductive performance.	High-strength potting and encapsulation material.
Adhesive / Seala	nt	•	•	•	•	•	
Adhesive / Seald Coating Encapsulant / Po							
Encapsulant / Po	otting						•
Mixing Ratio ((A):(B) by w	veight)	100:10	100:100	100:10	100:100	100:100	100:100
Color (mixed)		White	White	White	Reddish Brown	White	Black
Viscosity (mixed) (23°C)	Pa-s (P)	-	640 (6400) <sup>1</sup>	-	440 (4400) <sup>1</sup>	65 (650) <sup>1</sup>	40 (400) <sup>1</sup>
Application Rate	g/min	200	-	150	-	-	-
Pot Life (23°C)	h	48	24	-	1	4	4
Cure Condition	C/h	150/0.25	150/1	150/0.25	150/1	100/1	120/1
Specific Gravity (23°C)		1.17	1.12	-	2.11	1.54	1.16
Hardness		40	42	40	66	70	55
Tensile Strength	MPa (psi)	4.5 (650)	5.4 (785)	4.5 (650)	4.9 (710)	5.9 (855)	6.4 (930)
Elongation	%	275	380	275	120	100	270
Adhesive Strength	MPa (psi)	1.03 (150) <sup>2</sup>	3.1 (450) <sup>2</sup>	3.1 (450) <sup>3</sup>	2.6 (375) <sup>2</sup>	2.0 (290) <sup>2</sup>	3.9 (565) <sup>2</sup>
Thermal Conductivity	y W/m·k	-	0.23	-	0.63	0.63	0.29
Volume Resistivity	MΩ·m	1.0×10 <sup>6</sup>	1.0×10 <sup>7</sup>	1.0×10 <sup>6</sup>	2.0×10 <sup>6</sup>	1.0×10 <sup>7</sup>	2.0×10 <sup>6</sup>
Dielectric Strength	kV/mm	19.6	21	19.7	26	23	25
Dielectric Constant	60Hz	-	3.0	-	3.4	3.3	3.4
Dissipation Factor	60Hz	-	0.001	-	0.017	0.007	0.01
Flame Retardancy							
Low Volatility		•		•			
Temperature Resista	nce				•		
Thermally Conductiv	re				•	•	
FDA	nally conductive						
1kg can	1kg can		• •		• •		• •
_ 1.8kg can				•			
18kg pail 20kg pail				•			
20kg pail			• •				
5 gal. (18.9 ltr) po	ail	• •					
25kg pail						• •	

<sup>&</sup>lt;sup>1</sup>JIS K 6249 <sup>2</sup>AL-AL Lap Shear Adhesion <sup>3</sup>Steel Lap Shear Adhesion

Typical property data values should not be used as specifications

# Product Details - 2 Part Heat Cure Grades

	Properties		TSE:	3380	TSE3	423	RTV	615	TSE	3032	TSE3	3431	TSE34	¥31-H	TSE:	3330
Con	nponents		TSE3380 (A)	TSE3380 (B)	TSE3423 (A)	TSE3423 (B)	RTV615 (A)	RTV615 (B)	TSE3032 (A)	TSE3032 (B)	TSE3431 (A)	TSE3431 (B)	TSE3431-H (A)	TSE3431-H (B	TSE3330 (A)	TSE3330 (B)
Flov	wability		Flow	vable	Flow	able	Flov	vable	Flow	/able	Flow	able	Flow	able	Flow	vable .
Fea	tures and Benefits	5		conductive dhesive.	Thermally conduct / potting mate recognition, low te and excellent release.	erial with UL emperature cure,	/ potting m	y encapsulant naterial with o cure at RT. nognition.	Trans encapsula material wi release p	h excellent	Encapsula material with thermal con- excellent release	JL recognition, ductivity, and	Encapsula material with U thermal cond excellent relea	JL recognition, ductivity, and	material w	ant / potting with thermal activity.
App	Adhesive / Seala	nt														
Application	Coating															
tion	Encapsulant / Po	tting														
Mix	ing Ratio ((A):(B) by we	eight)	100	):100	100:	100	100	0:10	100	0:10	100	0:10	100	0:10	100	):100
Cold	Or (mixed)		Gr	ay	Gro	gy	Cle	ear	Trans	parent	Blo	ıck	Blo	ıck	Reddish	n Brown
Visc	cosity (mixed) (23°C)	Pa·s (P)	40 (4	100) <sup>1</sup>	6.2 (6	52) <sup>1</sup>	4.0 (	40) <sup>2</sup>	4.0 (	40) <sup>1</sup>	4.0 (	40) <sup>1</sup>	4.0 (	40) <sup>1</sup>	3.5 (	35) <sup>1</sup>
Pot	Life (23°C)	h		8	1		4	4	4	i	1	.5	1	.5		8
Cur	e Condition	C/h	150	0/0.5	60	/1	150	/0.25	10	0/1	10	0/1	10	0/1	12	0/1
Spe	cific Gravity (23°C)		2.	70	2.1	L7	1.	02	1.0	02	1.	50	1.	52	1.	57
Har	dness		7	'0	6!	5	4	.4	3	5	7	0	7	0	6	55
Ten	sile Strength	MPa (psi)	2.5	(365)	2.1 (3	305)	6.4 (	925)	4.5 (	655)	4.9 (	710)	4.1 (	595)	3.9 (	565)
Elor	ngation	%	10	00	70	)	16	50	21	LO	7	0	6	0	10	00
Adh	nesive Strength	MPa (psi)	1.5 (	220) <sup>3</sup>	-	-		-		-		-		-	1.5 (	220)3
The	rmal Conductivity	W/m.k	1.	68	1.	0	0.	19	0.	17	0.	63	0.0	53	0.	63
Volu	ume Resistivity	MΩ·m	2.1	×10 <sup>6</sup>	2.5×	(10 <sup>6</sup>	1.8	×10 <sup>7</sup>	2.0	≺10 <sup>7</sup>	5.0	≺10 <sup>6</sup>	5.0	≺10 <sup>6</sup>	2.0	×10 <sup>6</sup>
Diel	lectric Strength	kV/mm	1	.5	2:	1	19	9.7	2	1	2	6	2	7	2	!5
Diel	lectric Constant	60Hz	5	.7	4.	7	2.89 (	1kHz)	2.	.8	3	.4	3		3	.4
Diss	sipation Factor	60Hz	0.0	002	0.0	)2	0.0004	(1kHz)	0.0	01	0.0	14	0.0	14	0.0	)17
Flar	me Retardancy				UL94	V-1					UL94	+ V-0	UL94	+ V-0		
	v Volatility															
	nperature Resistar															
The	rmally Conductive	9														
FDA																
	100g bottle									•		•		•		
	500g bottle									•						
	1kg can		•	•							•		•		•	•
	1.5kg can															
	2kg can													•		
	2.5kg can											•		•		
_	5kg can															
Packaging	6kg can															
(agi	15kg can								•							
ng	18kg pail															
	20kg pail				•	•							•			
	25kg pail										•		•			
	1 lb. (454g) Kit															
	2 lb. (907gr) kit															
	10 lb. (4.5kg) Kit															
	44 lb. (20kg) Kit															
	100 lb. (45kg) Kit															
	440 lb. (200kg) ki	t														

<sup>\*</sup> TSE3331K unavailable in Europe and the Americas \* TSE3331K EX unavailable in Asia Pacific

<sup>&</sup>lt;sup>1</sup>JIS K 6249 <sup>2</sup>ASTM D2196 <sup>3</sup>AL-AL Lap Shear Adhesion <sup>4</sup>TSE3331K unavailable in Europe and the Americas <sup>5</sup>TSE3331K EX unavailable in Asia Pacific

			Nowable										
TSE	3331	TSE3	331K <sup>4</sup>	TSE333	1K EX <sup>5</sup>	RTV64	28	XE14-	B7892	TSE3	3033	YE5	822
												YE5822 (A)	
Flow											/able		/able
Thermally encapsula material recog	nt / potting with UL	encapsula material	nt / potting with UL	encapsula material	nt / potting with UL	viscosity se	alant. tion.	material with l	JL recognition, ure cure, and	Low vistranspencapsula	parent nt / potting	encapsula material.	y transparent int / potting Excellent properties
100	100	100	100	100	100	10011		100	100	100	100	10	2.1.2
	:100										:100		0:10
Gr 3.5 (										Transp 1.0 (		Transp	10) <sup>1</sup>
	3 <i>3)</i> 8									1.0 (			4
	0/1										/0.5		0/1
1.5										1.0			97
6										3			.7
2.9 (	420)	3.1 (	450)	3.0 (	440)	3.24 (47	70)	3.5 (	510)	1.0 (	145)		
7	0	17	20	10	00	60		10	00	13	30		-
1.3 (2	190)3	1.6 (2	230) <sup>3</sup>	1.6 (2	230)3	-			-	0.3 (	44)3		-
0.6										0.1			17
	×10 <sup>6</sup>						)6				<10 <sup>7</sup>		×10 <sup>7</sup>
2							1-1			2			1
3. 0.0		_	-							2. 0.0			.8
UL94										0.0	01	0.0	)OI
OLJ	1 0	0254 0		OLJ-	, , ,	0254 4	_	OLJ	1 0				
				•									
													•
	•	•	•	•	•			•	•	•	•	•	
	•												
•	•												
						•							
						•							

Typical property data values should not be used as specifications

# Product Details - 1 Part Gels

	Properties  wability atures and Benefits  cosity (23°C) Pas (P) re Condition C/h ecific Gravity (23°C) netration³ ermal Conductivity W/m.k lume Resistivity M\Omega: electric Strength kV/mm electric Constant 60Hz esipation Factor 60Hz		TSE3051	TSE3051-FR	TSE3051-L	TSE3051ST	TSE3053
Flov	wability		Flowable	Flowable	Flowable	Flowable	Flowable
Fea	tures and Benefits	i	Low viscosity	Low viscosity, UL recognition	Low viscosity, low penetration	Low viscosity, high strength	Low viscosity, high penetration
Visc	cosity (23°C)	Pa·s (P)	0.7 (7) <sup>1</sup>	0.7 (7) <sup>1</sup>	0.7 (7) <sup>1</sup>	0.7 (7) <sup>1</sup>	0.7 (7) <sup>1</sup>
Cur	e Condition	C/h	125/2	120/1	125/2	100/2	125/2
Spe	cific Gravity (23°C)		0.97	0.97	0.97	0.97	0.97
Pen	etration <sup>3</sup>		85	85	65	35	105
The	rmal Conductivity	W/m.k	0.17	0.17	0.17	0.17	0.17
Volu	ume Resistivity	M <b>Ω</b> ·m	1.0×10 <sup>7</sup>	5.0×10 <sup>7</sup>	1.0×10 <sup>7</sup>	1.0×10 <sup>7</sup>	1.0×10 <sup>7</sup>
Die	ectric Strength	kV/mm	18	18	18	18	18
Die	ectric Constant	60Hz	2.8	2.8	2.8	2.8	2.8
Diss	sipation Factor	60Hz	0.001	0.001	0.001	0.001	0.001
Flar	me Retardancy			UL94 V-1			
	White		0				
00	Clear		0	0	0		0
Color	Gray		•				
	Light Yellow					0	
Pac	1kg can		see adjacent matrix	•	•		•
Packaging	15kg can			•	•		•
gnif	20kg can					•	

TSE3051	W	С	G
1kg bottle	0	0	•
4kg can		0	
15kg can		0	
20kg pail		0	

W: White, C: Clear, G: Gray

# Product Details - 2 Part Gels

	Properties		TSE3	081	TSE3	080	TSE3	062	TSE306	5	TSE3	070	RTV61	L26-D1	RTV61	l36-D1	
Com	nponents		TSE3081 (A)	TSE3081 (B)	TSE3080 (A)	TSE3080(B)	TSE3062 (A)	TSE3062 (B)	TSE3065 (A) TSE3	065 (B)	TSE3070 (A)	TSE3070 (B)	RTV6126 (A)	RTV6126 (B)	RTV6126 (A)	RTV6126 (B)	
Flow	vability		Flow	able	Flow	able	Flow	<i>r</i> able	Flowabl	le	Flow	able	Flow	vable	Flow	vable	
Feat	tures and Benefit	S	Thermally of	conductive	Thermally of	conductive	Low tempe	rature cure	Low volatile	gel	High elon	gation gel	Extreme fast co	ure, low viscosity	Fast cure, I	ow viscosity	
Mixi	ing Ratio ((A):(B) by w	eight)	100:	100	100	:100	100	:100	100:10	0	100	100	10	0:100	0 100:100		
Colc	Or (mixed)		Bla	ck	Blo	ıck	Transp	parent	White		Transp	arent	Trans	parent	nt Transparer		
Visc	osity (mixed) (23°C)	Pa-s (P)	20 (2	00)1	7.0 (	70) <sup>1</sup>	1.0 (	10) <sup>1</sup>	0.85 (8.5	)1	0.8	(8) <sup>1</sup>	0.75	$(7.5)^2$	5) <sup>2</sup> 0.75 (7.5		
Pot	Life (23°C)	h	3		3	3	1	l	4		۷	ŀ	5 r	min	0	.5	
Cure	e Condition	C/h	100	)/1	100	0/1	70/	/0.5	80/5		70/	0.5	65	/0.3	100	0/0.3	
Spe	cific Gravity (23°C)		2.5	50	1.5	53	0.9	97	0.97		0.9	97	0.	98	0.	98	
Pen	etration³	10 25 5.		5	70		6	5	6	55	6	50					
The	rmal Conductivit <u>ı</u>	activity W/m.k 1.26 0.63 0.1		17	0.17		0.1	0.17		0.19		19					
Volu	ume Resistivity	vity $M\Omega$ m $1.0 \times 10^7$ $1.0 \times 10^7$		<10 <sup>7</sup>	1.0>	≺10 <sup>7</sup>	1.0×10	7	1.0>	1.0×10 <sup>7</sup>		×10 <sup>7</sup>	1.0	×10 <sup>7</sup>			
Diel	ectric Strength	kV/mm	2	2	2	2	1	8	18		1	8	20	20.5		0.5	
Diel	ectric Constant	60Hz	5.	0	3.	3	2.	.7	2.7			2.8 (	1kHz)				
Diss	sipation Factor	60Hz	0.0	03	0.0	)3	0.001		0.001		0.0	01	0.001	(1kHz)	0.001	(1kHz)	
Low	/Volatility																
Tem	nperature Resista	nce															
The	rmally Conductiv	e															
	1kg can				•												
	5kg can																
P	18kg pail																
ack	20kg can																
Packaging	2 lb. (907g) Kit																
g	18 lb. (8.2kg) Kit																
	80 lb. (36kg) Kit												(	•			
	800 lb. (360kg) K	it															



RTV	5156	RTV	5186					
RTV6156 (A)	RTV6156 (B)	RTV6156 (A)	RTV6156 (B)					
Flow	able	Flow	able					
Low temperatu	re performance	High strength. E	xtended pot life					
100:	:100	100:	100					
Transp	parent	Transp	parent					
0.75	$(7.5)^2$	0.75	$(7.5)^2$					
1	L	8						
10	0/1	10	0/1					
0.9	98	0.9	98					
4	0	6	0					
0.:	19	0.19						
1.0	≺10 <sup>7</sup>	1.0×10 <sup>7</sup>						
20		20.5						
2.8 (1	LkHz)	2.8 (1	LkHz)					
0.001	(1kHz)	0.001	(1kHz)					

Product Detail	s - 1 Part	JCR Gro	ades		
Properties	TSJ3155	TSJ3194	TSJ3190	TSJ3197	TSJ3195-W
Flowability	Semi-Flowable	Semi-Flowable	Flowable	Semi-Flowable	Semi-Flowable
Features and Benefits	Thixotropic JCR rubber. Low post-cure hardness contributes to stress relief of critical components.	Low viscosity JCR rubber.	Low viscosity JCR rubber with good light transmittance and stress relief performance.	Thixotropic JCR gel. Soft, low-penetration property contributes to stress and vibration relief.	Low viscosity JCR gel. providing stress and vibration relief performance.
Property	Rubber	Rubber	Rubber	Gel	Gel
Viscosity (23°C) Pa·s (P)	6 (60) <sup>1</sup>	4.5 (45) <sup>1</sup>	1.1 (11) <sup>1</sup>	110 (100) <sup>1</sup>	4 (40) <sup>1</sup>
Color	White	Black	Transparent	Translucent	White
Cure Condition C/h	150/4	150/4	150/4	150/4	150/4
Specific Gravity (23°C)	1.02	1.03	0.97	1.00	1.00
Hardness	11	41	12	-	-
Penetration <sup>2</sup>	-	-	-	40	80
Thermal Conductivity W/m-k	0.18	0.18	0.17	0.17	0.18
Volume Resistivity ΜΩ·m	1.0×10 <sup>7</sup>	1.0×10 <sup>7</sup>	1.0×10 <sup>7</sup>	5.0×10 <sup>7</sup>	1.0×10 <sup>7</sup>
Dielectric Strength kv/mm	20	20	20	21	15
Dielectric Constant 60Hz	2.8	2.8	2.8	2.7	2.8
Dissipation Factor 60Hz	0.0004	0.0004	0.001	0.001	0.0004
Na+K+	<2	<2	<2	<2	<2
2 1kg can		•	•		•
1kg can 500g bottle 1kg bottle	•				
1kg bottle				•	

<sup>&</sup>lt;sup>1</sup>JIS K 6249 <sup>2</sup>1/4" cone

Typical property data values should not be used as specifications

Product De	etails	- 2 F	Part	JCR	Gro	ides		
Properties		XE14-6	B3445	XE14-	B5778	TSJ3	3175	
Components		XE14-B3445 (A)	XE14-B3445 (B)	XE14-B5778 (A)	XE14-B5778 (B)	TSJ3175 (A)	TSJ3175 (B)	
Flowability		Semi-Fl	owable	Semi-F	lowable	Semi-Flowabl		
Features and Benefits	;	Thixotro <sub>l</sub>			ntrollable ubber.	contribute	property	
Property		Rubber		Rub	ber	G	el	
Mixing Ratio ((A):(B) by we	ight)	100:100		100:100		100:100		
Color (mixed)		Transl	ucent	Translucent		Blo	ıck	
Viscosity (mixed) (23°C)	Pa·s (P)	63 (6	30) <sup>1</sup>	14 (140) <sup>1</sup>		17 (1	.70) <sup>1</sup>	
Pot Life (23°C)	h	7:	2	3	3	1	2	
Cure Condition	C/h	150	0/1	80/2		12	5/2	
Specific Gravity (23°C)		1.1	10	1.	02	1.0	01	
Hardness		70	0	1	.6		-	
Penetration <sup>2</sup>		-	-		-	7	0	
Thermal Conductivity	W/m-k	0.2	20	0.	18	0.:	18	
Volume Resistivity	MΩ·m	1.0×	(10 <sup>7</sup>	5.0	×10 <sup>5</sup>	1.0	≺10 <sup>7</sup>	
Dielectric Strength	kV/mm	20	0	2	4	1	5	
Dielectric Constant	60Hz	2.	8	2	.7	2.	.7	
Dissipation Factor	60Hz	0.00	004	0.0	001	0.0	01	
Na+K+		<	2	<	:2	<	2	
Packagina: 500a bottl	e							

Packaging: 500g bottle

Typical property data values should not be used as specifications

 $<sup>^{1}</sup>$ JIS K 6249  $^{2}$ 1/4" cone

# Product Details - Grease

Properties	TSK5303	TSK5370	TSK550	TSK551	YG6111	YG6240	YG6260	
Features and Benefits	Thermally conductive compound for medium heat dissipation. Heat resistance.	Compound for electrical insulation and sealing with swell-resistant performance.	Compound for electrical contact insulation protection against moisture and contaminants.	Compound for electrical contact insulation protection against moisture and contaminants.	Thermally conductive compound for medium heat dissipation. Low oil separation.	Thermally conductive compound for medium heat dissipation. Low oil separation.	'	Thermally conductive compound for medium to high heat dissipation applications.
Color	White	White	White	Green	White	White	White	White
Specific Gravity	2.46	-	1.03	1.03	2.46	2.46	2.5	2.62
Penetration	330	270	220	220	310	290	300	340
Bleed (150°C, 24h) %	2.8	1.5	1.5	1.0	0.4	0.0	0.5	0.1
Evaporation (150°C, 24h) %	0.2	0.2	0.2	0.3	0.1	0.4	0.1	0.1
Thermal Conductivity W/m-k	0.8	-	-	-	0.84	0.84	0.84	1.0
Volume Resistivity MΩ·m	-	1.0×10 <sup>6</sup>	2.0×10 <sup>7</sup>	2.0×10 <sup>7</sup>	2.0×10 <sup>6</sup>	2.0×10 <sup>6</sup>	2.0×10 <sup>7</sup>	3.0×10 <sup>6</sup>
Dielectric Constant 60Hz	5.0	2.5	2.8	2.8	5.0	5.0	5.0	5.0
Dissipation Factor 60Hz	0.005	0.0001	0.0002	0.0002	0.006	0.006	0.005	0.006
Low Molecular Siloxane (D3-D10)	-	100	-	-	100	30	30	30
Arc Resistance	-	-	120<	120<	-	-	-	-
Low Volatility								
Temperature Resistance								
Thermally Conductive								
Low Bleed								
100g tube								
180g tube				•				
200g tube					•	•	•	
1kg can				•	•	•	•	
1kg can 2kg can 4kg can								•
4kg can			•	•				
8kg can	•							
15kg pail								
20kg pail					•	•	•	

Typical property data values should not be used as specifications

### Packaging Supplement

Grade	10	00g tu	be	130g	tube	33	33ml c	artrid	ge	1	.kg ca	n	4 kg can			g pail		20 kg pail
Grade	W	С	В	W	G	W	С	В	G	w	С	В	w	W	С	В	G	G
TSE370	0	0				0	0	•										
TSE382	0	0				0	0	•						0	0	•		
TSE387	0	0				0	0	•						0	0			
TSE388	0					0												
TSE389		0	•			0	0	•			0							
TSE392	0	0				0	0							0	0		•	
TSE3925	0	0				0	0								0			
TSE3944				0		0												
TSE397	0	0	•			0	0	•			0	•		0	0	•		
TSE398	0	0				0	0			0								
TSE399	0	0	•			0	0	•		0	0	•	0	0	0	•		
TSE3991	0	0					0	•			0	•			0	•		
TSE3995	0	0	•			0	0	•							0	•		
TSE3996	0	0	•			0	0	•				•		0				
ECS0601			•			0		•										

UL Status

source: Underwriters Laboratories Inc.

Гуре	Grade	Color	Thickness mm	R Elec.	TI Mech. STR	Flame Class	HWI (PLC)	HAI (PLC)	HVTR (PLC)	D495 (PLC)	CTI (PLC)	File No.
	ECS0601	Black Clear White	1.5	105	105	HB	-	-	(I LC)	(I LC)	(I LC)	E56745
	IS802	White	1.2 only	105	105	НВ	4	0	0	5	0	E36952
	IS803	Black	1.2 only	105	105	НВ	4	0	0	5	0	E36952
	IS806	Red	1.9 only	105	105	НВ	-	-	-		-	E36952
	IS808	Translucent	1.2 only	105	105	НВ	4	0	0	5	0	E36952
	IS800.09	Aluminum	1.5	105	105	НВ	-	-				E36952
	RTV133	Black	0.71	105	105	V-1	3	0	0	3	0	E36952
	RTV133	Black	1.6	105	105	V-1	2	0	-	-	-	E36952
	RTV133	Black	3.4	105	105	V-0	1	0				E36952
	RTV160	White	0.75	105	105	НВ	4	0	1	5	0	E36952
	RTV160	White	1.5	105	105	НВ	3	0			-	E36952
	RTV160	White	2.5	105	105	НВ	3	0				E36952
	RTV160	White	3.0	105	105	НВ	_	_				E36952
	RTV167	Gray	0.83	105	105	НВ	3	0	0	5	0	E36952
	RTV167	Gray	1.5	105	105	НВ	2	0				E36952
	RTV167	Gray	2.6	105	105	НВ	2	0				E36952
	TSE382	Clear White	0.75	105	105	НВ	4	0	0	4	0	E56745
	TSE382	Clear White	1.5	105	105	НВ	3	0				E56745
	TSE382	Clear White	1.9	150	140	НВ	3	0				E56745
	TSE382	Clear White	3.0	150	140	НВ	3	0				E56745
Ь	TSE3840-G	Gray	0.75	105	105	V-0	-	-	0	2	0	E56745
Part	TSE3840-G	Gray	1.5	105	105	V-0	0	0	Ŭ.	_	0	E56745
t C	TSE3840-G	Gray	3.0	105	105	V-0	0	0				E56745
bnd	TSE3843-W	White	1.1	105	105	V-1	-	_	0	1	1	E56745
ens	TSE3843-W	White	1.5	105	105	V-1	0	0		_	-	E56745
tai	TSE3843-W	White	1.9	150	140	V-1	-	_				E56745
Condenstaion Cure	TSE3843-W	White	2.5	150	140	V-1	_	_				E56745
Cur	TSE3843-W	White	3.0	150	140	V-1	_	_				E56745
Φ	TSE384-B	Black	1.2	105	105	V-0	0	0	0	3	1	E56745
	TSE384-B	Black	1.9	150	140	V-0	-	_			-	E56745
	TSE384-B	Black	3.0	150	140	V-0	_	_				E56745
	TSE3853-W	White	1.5	105	105	V-0	0	3	0	3	0	E56745
	TSE3853-W	White	3.0	105	105	V-0	0	3	Ŭ.	3	Ŭ.	E56745
	TSE3854D	Gray	0.75	105	105	V-0	0	0	0	3	0	E56745
	TSE3854D	Gray	1.5	105	105	V-0	0	0	, v		<u> </u>	E56745
	TSE3854D	Gray	3.0	105	105	V-0	0	0				E56745
	TSE3854D	White	1.5	105	105	V-0	0	3	0	3	0	E56745
	TSE3854D	White	3.0	105	105	V-0	0	3			<u> </u>	E56745
	TSE389	Clear White Black	1.5	105	105	HB	-	-				E56745
	TSE389	Clear White Black	3.0	105	105	НВ	_	_				E56745
	TSE392	Black Clear White Gray	1.5	105	105	НВ	_	_				E56745
	TSE392	Black Clear White Gray	3.0	105	105	НВ	_	_				E56745
	TSE392	Gray	0.75	105	105	V-1	_	_	0	4	0	E56745
	TSE3940	Gray	1.5	105	105	V-1	2	0	0	7	0	E56745
	TSE3940	Gray	3.0	105	105	V-0	2	0				E56745
	TSE3940	White	0.75	105	105	V-0 V-1	_	_	0	3	0	E56745
	TSE3941	White	1.5	105	105	V-1 V-1	2	0	0		0	E56745
	TSE3941	White	3.0	105	105	V-0	1	0				E56745
		PLC: Performance Level Category										

Type	Grade	Color	Thickness		TI	Flame	HWI	HAI	HVTR	D495	CTI	File No.
	TSE3944	Gray	mm 0.75	Elec. 105	Mech. STR 105	Class V-0	(PLC)	(PLC)	(PLC)	(PLC)	(PLC)	E56745
	TSE3944	White	0.75	105	105	V-1	_	_	0	3	0	E56745
⊢	TSE3944	Gray White	1.5	105	105	V-0	0	0		3		E56745
Part	TSE3944	Gray White	3.0	105	105	V-0	0	0				E56745
	TSE3945	Gray	3.3	105	105	V-0	2	0	0	1	0	E56745
ond	TSE3946	White	3.0	105	105	V-0	1	0	0	0	0	E56745
ens	TSE397	Clear White Black	1.5	105	105	HB	_	_	0	U	0	E56745
sta:	TSE397	Clear White Black	3.0	105	105	HB	_	_				E56745
on .	TSE3976-B	Black	0.64	105	105	НВ	_	_				E56745
Condenstaion Cure	TSE3976-B	Black	1.5	105	105	HB	_	_				E56745
ิดั	TSE3976-B	Black	3.0	105	105	НВ	_	_				E56745
	XE11-A5133S		3.0	105	105	V-1	_	_				E56745
	TSE3051-FR	Clear	2.7-3.3	105	105	V-1	_	-				E56745
	TSE322S	Clear	1.0	105	105	HB	_	_				E56745
	TSE322S	Clear	1.5	105	105	НВ	_	_				E56745
<u> </u>	TSE322S	Clear	3.0	105	105	V-1	-	-				E56745
Par	TSE3253	Black	1.3	105	105	V-1	_	_				E56745
Ϊ́	TSE3253	Black	2.0	105	105	HB						E56745
Part Heat Cure	TSE326	Red	1.0	105	105	НВ	_	_				E56745
C	TSE326	Red	3.0	105	105	НВ	_	_				E56745
<u>ق</u>	TSE3260	Red	1.0	190	190	HB	_	_				E56745
	TSE3260	Red	2.0	190	190	HB	_	_				E56745
	TSE3260	Red	2.6	190	190	НВ	_	_				E56745
	RTV6428	Gray	3.0	105	105	V-1	_	-				E36952
	RTV6428	Gray	6.0	105	105	V-0	_	_				E36952
	TSE3331	Black	1.0	105	105	V-0	_	_	0	0	0	E56745
	TSE3331	Black	1.6	105	105	V-0 V-0	_		0	U	0	E56745
	TSE3331	Black	2.0	105	105	V-0	_	-				E56745
	TSE3331	Black	3.0	105	105	V-0	_	-				E56745
	TSE3331K	Black	2.5	105	105	V-0	_	_				E56745
	TSE3331K	Black	3.0	105	105	V-0	_	_				E56745
	TSE3331K*EX	Black	2.5	105	105	V-0	_	_				E56745
	TSE3331K*EX		3.0	105	105	V-0	_	_				E56745
~	TSE3423	Gray	3.0	105	105	V-1	_	_				E56745
Part	TSE3431	Gray	2.0	105	105	V-1	-	-				E56745
🕂	TSE3431	Gray	4.0	105	105	V-1	_	_				E56745
	TSE3431-H	Gray	1.0	105	105	V-0	0	0	0	1	1	E56745
	TSE3431-H	Gray	1.5	105	105	V-0	-	-	-			E56745
	TSE3431-H	Gray	2.5	105	105	V-0	0	0				E56745
	TSE3431-H	Gray	3.0	105	105	V-0	-	-				E56745
	TSE3664	Gray	1.0	105	105	V-1	-	-				E56745
	TSE3664	Gray	2.0	105	105	V-0	-	-				E56745
	TSE3664	Gray	3.0	105	105	V-0	-	-				E56745
	XE14-B7892		2.0	105	105	V-1	-	-				E56745
	XE14-B7892	Black	3.0	105	105	V-0	-	-				E56745
	1040	-				LIVED						

HWI Resistance to ignition when exposed to high temperatures. Expressed as the mean number of seconds required to ignite a specimen when wrapped with an energized ni-chrome resistive wire that dissipates a specified level of energy.

Mean Ignition
Time (sec)
≥ 120
60 - 119
30 - 529
7 - 14
<7

Ability to withstand
Ability to withstand
Bypressed as the number of arc rupture exposures required to ignite a specimen when the arc occurs directly on the surface or a specified distance above the test specimen specimen.

Mean No. of Arcs ≥ 120 60 - 119 30 - 59 15 - 29 <15

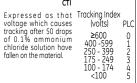
HAI

HVTR Expressed as the rate (inches per minute) that a tracking path can be produced on the surface of the material under standardized test PLC conditions.



D495 

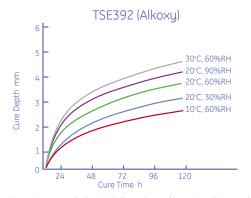
CTI

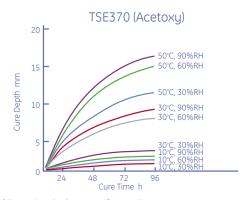


### **Cure Properties**

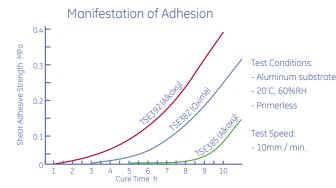
### Condensation Cure Grades

Condensation cure grades cure with exposure to atmospheric moisture. The cure process begins from the outer surface and proceeds inward. Therefore, deep section curing (in excess of 6mm) is not recommended. Typically, tack-free is achieved in 5-60 minutes at  $25^{\circ}$ C, 50%RH, depending on the grade.





Cure Time Test Method: Liquid silicone inserted in a 10mm diameter glass tube, and measurements of the cure length taken at specific intervals

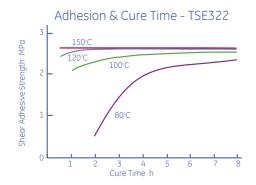


Adhesion is typically achieved after 5-15 hours. Full material properties including electronic performance, is achieved in up to 7 days.

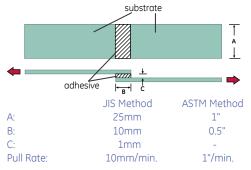
### Heat Cure Grades

Heat cure grades consist of either 1 part or 2 part grades, and are characterized by a cure mechanism this is triggered by exposure to heat. Cure performance is affected by temperature and time, resulting in a variety of cure profiles based upon the combination of these variables. The following examples demonstrate the effect of temperature and time in hardness change and manifestation of adhesive strength.





### Shear Adhesion Test Method



# Typical Adhesion Performance Condensation Cure Grades

Substrate			Alkoxy	(TSE392)		Acetoxy (TSE370)			Oxime (TSE382)			
	Substrate	Primerless	ME121	ME123	XP80-A5363	Primerless	ME121	ME123	Primerless	ME121	ME123	XP80-A5363 / YP9341
	Copper	•	•			•1	• 1		<b>▲</b> <sup>1</sup>	<b>•</b> ¹		
Metals	Steel	•	•			<b>A</b>	•		•	•		
	Brass	•	•			<b>^</b> 1	<b>^</b> 1		<b>▲</b> <sup>1</sup>	<b>•</b> <sup>1</sup>		
	Stainless Steel	•	•			<b>A</b>	•		<b>A</b>	•		
	Aluminum	•	•			•	•		•	•		
	Galvanized Steel	•	•				•		•	•		
	Tin	•	•			•	•		•	•		
	Acrylic Resin	•		•		×		•	•	•		
	Phenol Resin	•		•		•		•	•	•		
	Epoxy Resin	•		•		•		•	•	•		
	Polycarbonate	• <sup>2</sup>		•²					<b>•</b> <sup>2</sup>	<b>•</b> <sup>2</sup>		
	Soft Polyvinyl Chloride	•		•		×		•	×	×	•	
	Rigid Polyvinyl Chloride	•		•		•		•	•	•	•	
	Polyester Film	•		•		<b>A</b>		•	•	•	•	
ס	Unsaturated Polyester	•		•		•		•	•	•	•	
Plastic	Polyamide	•		•		•		•	•	•	•	
:ic	Nylon 66	•		•					•		•	<b>3</b>
	PBT	•		•					<b>A</b>		•	
	PPS	•		•					<b>A</b>		•	<b>3</b>
	ABS	•		•		•		•	•	•	•	
	Polypropylene	×		×	•				×	×	×	•4
	Polyethylene	×		×	<b>A</b>	×		×	×	×	×	
	Fluorocarbon Resin	×		×		×		×	×	×	×	
	Silicone Resin Laminate	•		•		•		•	•	•		
	Chloroprene Rubber	<b>A</b>		•		<b>A</b>		•	<b>A</b>		•	
Rubber	Nitrile Rubber	<b>A</b>		•		•		•	<b>A</b>		•	
	Styrene Butadiene Rubber	<b>A</b>		•					<b>A</b>		•	
	Ethylene Propylene Rubber	<b>A</b>		•					<b>A</b>		•	
	Silicone	•		•		•		•	•		•	
Inorganic	Glass	•	•			•	•		•	•		
gani	Ceramic	•	•			•	•		•	•		

lacktriangle Adheres completely, lacktriangle Adheres, but separates from surface when pulled, lacktriangle Does not adhere

### **Heat Cure Grades**

TSE322						
	Substrate	Adhesion				
	Aluminum	•				
3	Copper	•				
Metals	Brass	•				
S	Stainless Steel	•				
	Nickel Plate	•				
	PPS	•				
Pla	PBT	•				
Plastic	Epoxy Resin	•				
	Polyester	•				
Inorgania	Glass	•				
ganic	Ceramics	•				

Adheres completely

 $<sup>^1</sup>$  May corrode under some usage conditions,  $^2$  Stress cracking may occur under some usage conditions,  $^3$  YP9341,  $^4$  XP80-A5363

### Frequently Asked Questions

#### What does RTV mean?

RTV stands for Room Temperature Vulcanization (cure). Despite the low-temperature connotations conveyed by this name, RTV silicones consist of *both* Room Temperture Cure *and* Heat Cure grades.

### What is the cure mechanism of a condensation cure product?

Condensation cure silicone products cure when exposed to atmospheric moisture. Moisture in the air is generally required to cure (or vulcanize) condensation cure products. The cure process begins from the outer surface, and therefore time is required for complete cure. The cure time is affected by the reaction mechanism and viscosity of the material. Generally, at 25C and 50%RH, condensation cure RTV silicones cure through in 24 to 48 hours. Full physical properties may take up to 7 days to develop.

### What is the depth (bead thickness) limitation for a condensation cure grade?

For 1-part, condensation cure products, the depth (bead thickness) limitation is approximately 6mm (1/4"). For 2-part, condensation cure products, the depth (bead thickness) limitation is approximately 25mm (1").

#### Can I accelerate the cure time of a 1-part product?

Condensation cure silicone cure rates depend on humidity, silicone thickness, and to a smaller degree heat. Increasing the relative humidity around the silicone or reducing the thickness of the material will reduce the time to cure the material. Increased heat (not over 50C) will somewhat reduce cure time but as mentioned will do so to a much smaller degree than humidity or thickness.

#### What is the cure mechanism of an addition cure product?

Addition cure silicone RTV products may be 1 or 2-part and cure when exposed to heat. Although some heat cure products can cure at room temperature, higher heat greatly accelerates the cure. 1-part heat cure products typically have an inhibitor in the formulation that stops the product from curing until an activation temperature, greater than room temperature, is achieved and the inhibitor is driven off and the cure reaction is allowed to proceed.

#### What does "tack free time" mean?

Tack free refers to the amount of time it takes for a condensation cure silicone product to form a cured outer layer (the cured outer layer is not tacky like uncured material).

#### What is "mix ratio"?

Mix ratio is a term used to state the amount of each material to be in a multi-component material. The mix ratios for 2-part products are described on the individual product data sheets and are given as a ratio by weight of each material.

#### What does "pot life" or "work life" mean?

The amount of time after a 2-part grade is mixed with its curing agent that it will remain useful or pliable.

#### How do I remove silicone?

Before it is cured: use a putty knife to remove any of the uncured paste. Wipe the area clean with isopropyl alcohol to remove any leftover residue. After it is cured: First mechanically remove as much of the silicone as you can with either a knife or a razor. A solvent (mineral spirits, toluene, xylene, acetone) can them be used to remove any oily residue or any remaining silicone, It may be necessary to soak the silicone in a solvent overnight to break it down.

#### Can I thin a silicone?

Silicone can be thinned using a solvent in which the silicone is miscible, generally an aromatic solvent such as toluene or xylene. As always, be sure to follow the producer's instructions when using solvent products and always use in a well-ventilated area. The shrinkage of the silicone and the cure time will increase with the addition of solvent. Alternative suggestions would include non-reactive fluids or an RTV with a lower viscosity.

### What can I do to improve the adhesion of the silicone adhesive to my parts?

The first step to good adhesion is to have clean surfaces for the silicone to bond to. For difficult-to-bond-substrates, GE -Advanced Materials, Silicones offers a number of primers that can be used to improve and maximize adhesion.

#### How do I ensure that air is removed from 2-part grades?

If you are hand mixing, air may become added to the material during the mixing process. Vacuum de-airing is most effective in removing air prior to use. Automated mixing equipment that utilizes a static mixer can eliminate the need to de-air prior to dispensing.

On complex high-density electronics, air can sometimes be trapped under components during the potting process. Where this is a concern, potting under vacuum or vacuum de-airing after potting can remove the trapped air. An alternate approach may be to use a grade with a low viscosity and longer potlife and to cure at lower temperatures (if heat-cure grade), allowing entrapped air to escape prior to the cure of the material.

### What is cure inhibition, and how do I prevent it?

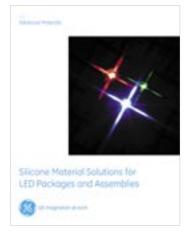
Cure inhibition is a phenomenon that may be observed in addition-cure grades. These materials use a platinum catalyst to drive the curing reaction. Surfaces containing water, sulphur, nitrogen compounds, organic metal compounds, or phosphate compounds, may inhibit cure.

Cure inhibition is characterized by a gummy or sticky appearance of the silicone at the interface between the silicone and offending substrate. Inhibition can be prevented by application of a barrier coat, cleaning of the offending material prior to application of the silicone material, replacing the offending material with a suitable alternative, or selection of a condensation cure grade.

### Other Electronic Solutions from GE - Advanced Materials, Silicones



12-page brochure provides detailed information on silicone materials used for thermal management applications in electronics and micro-electronics. Includes SilCool\* grease & adhesives, and conventional grades for adhesion, encapsulation and potting.



12-page brochure providing opto-electronic solutions for LED Packages and Assemblies. Includes InvisiSil\* LED encapsulants, Glob Top, Lens fabrication materials, Die Attach adhesives, and Dot Matrix assembly materials.

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